

# An accelerated algorithm for 2D simulations of the quantum ballistic transport in nanoscale MOSFETs

Claudia NEGULESCU <sup>1</sup>, Naoufel BEN ABDALLAH <sup>1</sup> and Mireille MOUIS <sup>2</sup>

## Abstract

An accelerated algorithm for the resolution of the coupled Schrödinger/Poisson system, with open boundary conditions, is presented. This method improves the subband decomposition method (SDM) introduced in [N. Ben Abdallah, E. Polizzi, *Subband decomposition approach for the simulation of quantum electron transport in nanostructures*, J. Comp. Phys. **202** (2005), no. 1, 150–180]. The principal feature of the here presented model consists in an inexpensive and fast resolution of the Schrödinger equation in the transport direction, due to the application of the WKB approximation. Oscillating WKB basis elements are constructed and replace the piecewise polynomial interpolation functions used in SDM. This procedure is shown to reduce considerably the computational time, while keeping a good accuracy.

**Keywords :** Schrödinger-Poisson equation; Open boundary conditions; Subband model; WKB approximation; Confinement effects; Quantum tunneling.

---

<sup>1</sup>Mathématiques pour l'Industrie et la Physique, UMR CNRS 5640, Université Paul Sabatier  
118, route de Narbonne, F-31062 Toulouse Cedex, France  
Email: negulescu@mip.ups-tlse.fr, naoufel@mip.ups-tlse.fr

<sup>2</sup>IMEP (UMR CNRS/INPG/UJF), 23 rue des Martyrs, BP 257, F-38016 Grenoble Cedex, France  
Email: mouis@enserg.fr

# 1 Introduction

MOSFET size dimensions continue to decrease rapidly towards the sub-10 nm range. The interest for such a scaling is multiple: more functionality, higher operating speeds, reduced power consumption. To support this effort, it is of primary importance to develop modeling and simulation tools that are adequate for the description of ultra small devices. The objective of this paper is the presentation of a very efficient and inexpensive method for the simulation of nanoscale MOSFET devices.

The scaling of devices beyond a certain limit enhances the importance of some physical phenomena, with correlated consequences on device modeling techniques. The electron transport becomes near-ballistic and quantum effects can no more be neglected. The quantum ballistic transport models are thus adequate to describe what can be ultimately expected in these devices. The approach presented in this paper is based on the resolution of the self-consistent Schrödinger-Poisson equation with open boundary conditions, which enable the current flow. It is an alternative to the self-consistent non-equilibrium Green's function formalism coupled to the Poisson equation (see [8]).

The resolution of the self-consistent Schrödinger-Poisson system with open boundary conditions has been the subject of several papers. In previous works of E. Polizzi [22] respectively S.E. Laux, A. Kumar, M.V. Fischetti [18], the Schrödinger-Poisson equation is solved self-consistently via a variational formulation in the whole definition/simulation domain. The first approach uses the original QTBM boundary conditions [19], whereas the second one extends these boundary conditions to simulate devices far from equilibrium. But these approaches are very time consuming due to the expensive resolution of the 3D or 2D Schrödinger equation.

In a recent work of N. Ben Abdallah and E. Polizzi [6], a subband decomposition method (SDM) was proposed for the resolution of the 2D Schrödinger equation in order to reduce the numerical cost. The SDM method is based on the fact, that in modern devices the electron gas is confined in one or more directions and that consequently the dimension of the propagation space is reduced. Hence the resolution of the Schrödinger equation in the whole 2D domain is replaced by the resolution of 1D eigenvalue problems in the confined direction and a system of coupled 1D Schrödinger equations projected on the transport direction. This last system has to be solved for each discretized value of the incoming wave energy. The originality of the SDM method is that it retains however the coupling effects in the two directions of space.

The aim of this paper is to propose an improvement of SDM. This new method, further named SDM/WKB, aims at reducing considerably the simulation time by improving the resolution of the 1D Schrödinger equation through the use of the WKB approximation. This WKB approximation was introduced by N. Ben Abdallah and O. Pinaud in [5] in the 1D case, for the simulation of a resonant tunneling diode (RTD). The present paper extends this method to the 2D case, combining it with the just mentioned SDM method. The principal idea of the here introduced SDM/WKB method is the following. The SDM method uses the finite element approach to solve the 1D Schrödinger equation in the transport direction and as such a refined mesh size is necessary in this direction

to accurately approximate the highly oscillating wave functions, which correspond to high injection energies. The originality of the WKB method consists in using oscillating interpolation functions instead of the linear or polynomial ones. It takes advantage of the fact, that these oscillating interpolation functions have a frequency close to that of the unknown wavefunction. Thus accurate results can be obtained with much coarser grids, leading for this reason to a reduced simulation time.

The outline of this paper is the following. Section 2 starts by presenting briefly the SDM method. Afterwards we introduce the new SDM/WKB method. In the end of this section, we compare the two methods from a numerical point of view (simulation time, accuracy). Section 3 enumerates some interesting points concerning the implementation of the SDM/WKB method. Finally, Section 4 is devoted to the discussion of the numerical results obtained with the SDM/WKB method. Several devices have been analyzed and compared in order to validate the results from a physical point of view. To keep this paper simple, we preferred to present the extensive mathematical and numerical analysis of this model in a separate future work [20].

## 2 Description of the SDM/WKB model

The purpose of this section is to present the original 3D SDM/WKB transport model, developed for the simulation of the ballistic quantum electron transport in nanoscale MOSFETs. This paper deals with the stationary problem.

The double-gate MOSFET, which has been used as a test structure for this numerical study, is schematically represented in Figure 1. It is a symmetrical device, consisting in a *Si*-channel separated by thin *SiO<sub>2</sub>* insulator layers from the two gate contacts. A

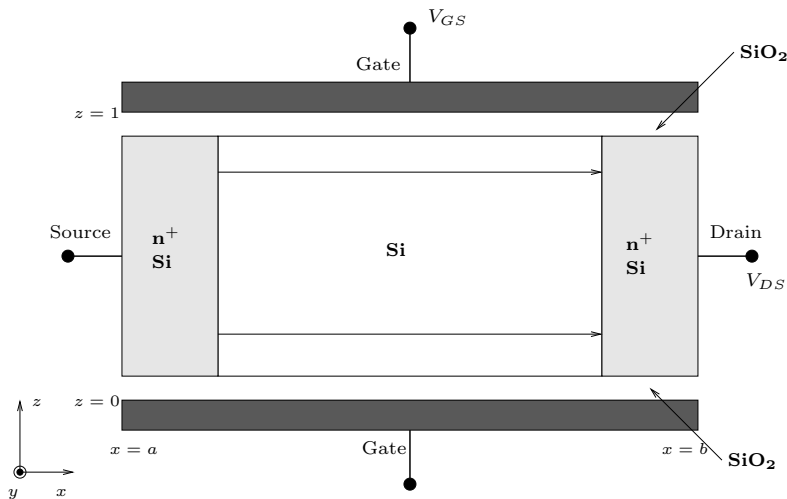


Figure 1: Schematic representation of the modeled device.

drain-source voltage  $V_{DS}$  is applied to create an electron flow in the  $x$ -direction, whereas

a gate-source voltage  $V_{GS}$  controls the conductivity of the  $Si$ -channel. Electrons are injected from the source and the drain reservoirs. These two reservoirs are assumed to be in a thermal equilibrium state, characterized by different Fermi energy levels.

The electron gas is supposed to be confined in the direction  $z$ . It is exactly upon this important feature, that the SDM method is based. The confinement induces the discretization of the energy continuum and thus the creation of energy-subbands in the transverse direction. The electron motion is allowed in the remaining two directions. The  $y$ -direction is assumed to be translational invariant, such that the  $x$ -direction shall be considered in the sequel as the transport direction. Because of the translational invariance in the  $y$ -direction, the simulation domain is limited to a 2D domain,  $(x, z) \in [a, b] \times [0, 1]$ , including the two oxide layers and parts of the source and the drain regions. The source and the drain are modeled by highly doped  $n^+$ -regions, whereas the  $Si$ -channel is assumed to be undoped ( $10^{16}cm^{-3}$  residual doping level).

We account in this model for the anisotropic crystal structure of  $Si$ , illustrated by six equivalent conduction band ellipsoids. This gives rise to two different effective masses, the longitudinal heavy effective mass  $m_l = 0.98 * m_e$  and the transversal light effective mass  $m_t = 0.19 * m_e$ , where  $m_e$  stands for the electron rest mass. Note that as the oxide layer is included into the modeled domain, the effective masses depend on the variable  $z$ .

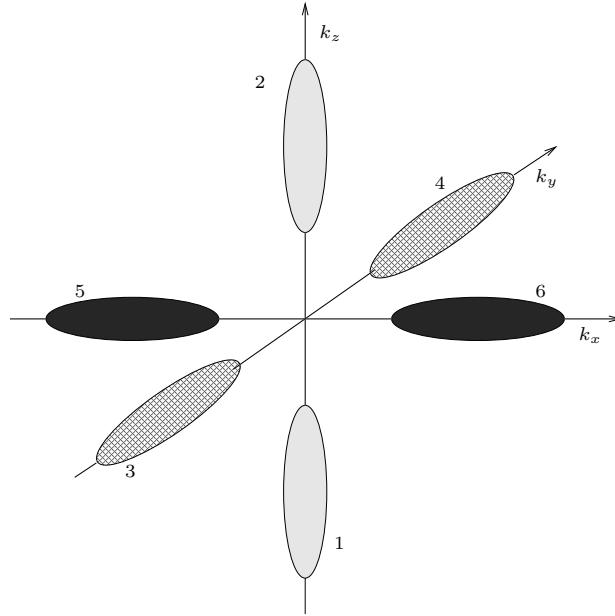


Figure 2: The six equivalent conduction band ellipsoids of  $Si$ .

Let us now briefly introduce the SDM method (for more details see [6]) and pass then to the extension SDM/WKB, based on the WKB approximation [5].

## 2.1 The SDM method

The coupled Schrödinger-Poisson equation is the most appropriate model to describe the quantum, ballistic electron transport. Due to the non-linearity, an iterative method (Gummel iteration) will be used for the resolution of this system, consisting of two blocs: the resolution of the Schrödinger equation and the resolution of the Poisson equation.

Quantum mechanically the electron evolution is described by means of the stationary Schrödinger equation

$$(H - qV(x, z))\Psi_E(x, y, z) = E\Psi_E(x, y, z), \quad (2.1)$$

with  $(x, y, z) \in [a, b] \times \mathbb{R} \times [0, 1]$  and where  $H$  is the Hamiltonian, defined by

$$H = -\frac{\hbar^2}{2} \left( \frac{1}{m_x(z)} \Delta_x + \frac{1}{m_y(z)} \Delta_y \right) - \frac{\hbar^2}{2} \frac{\partial}{\partial z} \left( \frac{1}{m_z(z)} \frac{\partial}{\partial z} \right). \quad (2.2)$$

We denoted by  $\Psi_E$  the complex-valued wave function, depending on the electron injection energy  $E$ . Furthermore  $\hbar$  is the Planck constant,  $q$  the elementary electron charge and  $m_x$ ,  $m_y$ ,  $m_z$  are the  $z$ -dependent effective masses in the  $x$ -,  $y$ - respect.  $z$ - direction. The electrostatic potential  $V$  depends only on the confinement and the transport direction and is split into a given exterior potential  $V_e$ , and a selfconsistent one  $V_s$ . The self-consistent potential is solution of the Poisson equation

$$\begin{cases} -\Delta V_s(x, z) = -qn(x, z) \\ \partial_{\mathbf{n}} V_s(a, \cdot) = \partial_{\mathbf{n}} V_s(b, \cdot) = 0 \\ V_s(\cdot, 0) = V_g^0, \quad V_s(\cdot, 1) = V_g^1, \end{cases} \quad (2.3)$$

where  $\partial_{\mathbf{n}}$  denotes the normal derivative to the boundary and  $V_g^0$ ,  $V_g^1$  are the applied gate voltages. The Neumann boundary conditions at the device/lead interface are more appropriate in ballistic devices than the Dirichlet boundary conditions, in order to ensure the charge neutrality in the leads. The electron density  $n$  is derived on it's turn from the wave function  $\Psi_E$ , as follows

$$n = \int |\Psi_E(x, y, z)|^2 f_{FD}(E) dE,$$

with  $F_{FD}$  the Fermi-Dirac distribution function. The exact expression is given in (2.14), (2.15).

Due to the translational invariance of the problem in the  $y$ -direction, the wave function  $\Psi_E$ , can be decomposed as

$$\Psi_E(x, y, z) = e^{ik_y y} \psi_\epsilon(x, z), \quad \text{with} \quad E = \epsilon + \frac{(\hbar k_y)^2}{2m_y}, \quad (2.4)$$

where  $\psi_\epsilon$  is solution of the 2D Schrödinger equation in  $[a, b] \times [0, 1]$

$$-\frac{\hbar^2}{2} \frac{1}{m_x(z)} \Delta_x \psi_\epsilon(x, z) - \frac{\hbar^2}{2} \frac{\partial}{\partial z} \left( \frac{1}{m_z(z)} \frac{\partial}{\partial z} \psi_\epsilon(x, z) \right) - qV(x, z) \psi_\epsilon(x, z) = \epsilon \psi_\epsilon(x, z). \quad (2.5)$$

We denote by  $k_y$  the wave vector in the  $y$ -direction and by  $\bar{m}_y$  the mean value of  $m_y$  over the whole  $(x, z)$ -domain, with  $\psi_\epsilon$  as weight function

$$\bar{m}_y[\psi_\epsilon] := \frac{\int_a^b \int_0^1 m_y(z) |\psi_\epsilon(x, z)|^2 dz dx}{\int_a^b \int_0^1 |\psi_\epsilon(x, z)|^2 dz dx}, \quad (2.6)$$

The SDM method is now applied to reduce the numerical cost for the resolution of the 2D Schrödinger equation (2.5). This method consists in expanding  $\psi_\epsilon$  in the  $L_z^2(0, 1)$  orthonormal basis  $\{\chi_i(z; x)\}$  as

$$\psi_\epsilon(x, z) = \sum_i \varphi_\epsilon^i(x) \chi_i(z; x), \quad (2.7)$$

where the basis functions  $\chi_i$  are the transversal wave functions, solutions of the 1D eigenvalue problem in the confinement direction

$$\begin{cases} -\frac{\hbar^2}{2} \frac{\partial}{\partial z} \left( \frac{1}{m_z(z)} \frac{\partial}{\partial z} \chi_i(z; x) \right) - qV(x, z) \chi_i(z; x) = E_i(x) \chi_i(z; x) \\ \chi_i(\cdot; x) \in H_0^1(0, 1), \quad \int_0^1 \chi_i(z; x) \chi_j(z; x) dz = \delta_{ij}, \end{cases} \quad (2.8)$$

and the longitudinal wave functions  $\varphi_\epsilon^i$  are the solutions of the coupled 1D Schrödinger equations in the transport direction

$$\begin{cases} -\frac{d^2}{dx^2} \varphi_\epsilon^i(x) - 2 \sum_{j=1}^{\infty} a_{ij}(x) \frac{d}{dx} \varphi_\epsilon^j(x) - \sum_{j=1}^{\infty} \left( b_{ij}(x) + \frac{2}{\hbar^2} c_{ij}(x) (\epsilon - E_j(x)) \right) \varphi_\epsilon^j(x) = 0 \\ + \text{open boundary conditions.} \end{cases} \quad (2.9)$$

The index  $i$ , called transversal mode, indicates the different subbands.  $E_i$  and  $\chi_i$  represent the potential energy and the transversal wave function of the electrons belonging to the  $i^{\text{th}}$  subband. The coupling terms between the different subbands,  $a_{ij}$ ,  $b_{ij}$  and  $c_{ij}$  are given by

$$a_{ij}(x) := \int_0^1 \chi_i(z; x) \frac{\partial}{\partial x} \chi_j(z; x) dz, \quad (2.10)$$

$$b_{ij}(x) := \int_0^1 \chi_i(z; x) \frac{\partial^2}{\partial x^2} \chi_j(z; x) dz, \quad (2.11)$$

$$c_{ij}(x) := \int_0^1 m_x(z) \chi_i(z; x) \chi_j(z; x) dz. \quad (2.12)$$

The open boundary conditions completing the Schrödinger equations (2.9) are calculated by assuming that the potential is only dependent on the variable  $z$  outside the device, in the two electron leads (thermal equilibrium condition). The thus obtained plane wave solutions in the leads are linked via continuity conditions with the solutions inside the

channel, giving rise to the following so called open boundary conditions (current-carrying conditions) [19]

$$\begin{cases} \frac{d}{dx}\varphi_\epsilon^i(a) = \mathbf{i}k_{x,i}^a(2\alpha_{i,\epsilon}^a - \varphi_\epsilon^i(a))\delta_{i \leq I_a(\epsilon)} + k_{x,i}^a\varphi_\epsilon^i(a)\delta_{i > I_a(\epsilon)} \\ \frac{d}{dx}\varphi_\epsilon^i(b) = -\mathbf{i}k_{x,i}^b(2\alpha_{i,\epsilon}^b - \varphi_\epsilon^i(b))\delta_{i \leq I_b(\epsilon)} - k_{x,i}^b\varphi_\epsilon^i(b)\delta_{i > I_b(\epsilon)}, \end{cases} \quad (2.13)$$

where  $\alpha_{i,\epsilon}^r$  denotes the amplitude of the incoming wave, penetrating the device from the source  $r = a$  or from the drain  $r = b$ , in the  $i^{\text{th}}$  transversal mode and with the injection energy  $\epsilon$ . The corresponding longitudinal wave vector  $k_{x,i}^r$  is given by

$$k_{x,i}^r(\epsilon) := \frac{\sqrt{2\bar{m}_x(\epsilon - E_i(r))}}{\hbar},$$

where  $\bar{m}_x$  stands for the mean value of the effective mass  $m_x$ , defined by

$$\bar{m}_x[\chi_i(\cdot, r)] := \int_0^1 m_x(z)|\chi_i(z; r)|^2 dz.$$

We have chosen the transversal wave function as weight, to account for the nonuniform electron distribution in the  $z$ -direction. Moreover,  $I_r(\epsilon)$  is the number of propagating modes

$$I_r(\epsilon) := \sup\{i \in \mathbb{N} \mid \epsilon > E_i(r)\}.$$

In other words, the boundary conditions (2.13) express the fact, that a wave coming from a reservoir and penetrating the device at  $x = a$  or  $x = b$  is partially reflected and transmitted by the potential barrier. The transmitted part can be an evanescent wave. We shall denote in the sequel the solution of (2.9), (2.13) corresponding to one incoming wave from the reservoir  $r_0$ , in the transversal mode  $i_0$ , with the energy  $\epsilon$  and amplitude one by  $\varphi_{r_0, i_0, \epsilon}$  and the corresponding 2D wave by  $\psi_{r_0, i_0, \epsilon}$ . In this case we have for the amplitude  $\alpha_{i,\epsilon}^r = \delta_{i, i_0} \delta_{r, r_0}$ . The electron density for a given effective mass configuration is now given as the superposition of densities of these scattering states

$$n_{m_x, m_y, m_z}(x, z) = 2 \sum_{r_0=a,b} \sum_{i_0=1}^{\infty} \int_0^{\infty} |\psi_{r_0, i_0, \epsilon}(x, z)|^2 \left( \int_{-\infty}^{\infty} f_{FD}(E; \mu_{r_0}) \frac{dk_y}{2\pi} \right) \frac{dk_x}{2\pi}, \quad (2.14)$$

where the Fermi-Dirac distribution function  $f_{FD}$  characterizes the electron injection in the device and is given by the formula

$$f_{FD}(E, \mu_{r_0}) := \frac{1}{1 + \exp\left(\frac{E - q\mu_{r_0}}{k_B T}\right)}.$$

The electron temperature is denoted by  $T$ ,  $k_B$  is the Boltzmann constant and the chemical potential  $\mu_{r_0}$  is deduced from

$$\mu_{r_0} = \mu + V_{r_0},$$

with  $\mu$  the chemical potential at equilibrium, when no drain-source voltage  $V_{DS}$  is applied, and  $V_{r_0}$  is the applied potential at  $x = r_0$ . The factor 2 in (2.14) comes from the Pauli principle. The energy-wavevector relations are

$$\epsilon(r_0, i_0, k_x) = E_{i_0}(r_0) + \frac{(\hbar k_x)^2}{2\bar{m}_x}, \quad E(r_0, i_0, k_x, k_y) = E(\epsilon, k_y) = \epsilon + \frac{(\hbar k_y)^2}{2\bar{m}_y}.$$

The total electron density, defined as the sum of the contributions corresponding to the different effective mass configurations

$$n(x, z) = 2(n_{m_t, m_t, m_l} + n_{m_t, m_l, m_t} + n_{m_l, m_t, m_t}), \quad (2.15)$$

allows now to calculate the selfconsistent potential by solving (2.3) and to restart the Schrödinger-Poisson iteration. Once self-consistency achieved, the electron current is computed as

$$j_{m_x, m_y, m_z}(x, z) = 2 \sum_{r_0=a, b} \sum_{i_0=1}^{\infty} \int_0^{\infty} \frac{q\hbar}{\bar{m}_x} \mathcal{I}m\{\bar{\psi}_{r_0, i_0, \epsilon}(x, z) \nabla \psi_{r_0, i_0, \epsilon}(x, z)\} \left( \int_{-\infty}^{\infty} f_{FD}(E; \mu_{r_0}) \frac{dk_y}{2\pi} \right) \frac{dk_x}{2\pi}, \quad (2.16)$$

and, in the same manner, the total current is given by

$$j(x, z) = 2(j_{m_t, m_t, m_l} + j_{m_t, m_l, m_t} + j_{m_l, m_t, m_t}). \quad (2.17)$$

Due to the fact, that at a fixed temperature the probability to find an electron at high energies is insignificant, we shall take into account in the numerical approximation only a finite number of transversal modes, denoted in the sequel by  $M$ , such that the index  $i_0$  runs over  $i_0 = 1, \dots, M$  in (2.14) and (2.16).

The advantage of the SDM method is, that it reduces the initial 2D Schrödinger equation (2.5) to the resolution of 1D eigenvalue problems in the confined direction and many 1D Schrödinger equations projected on the transport direction. Thus the size of the linear system to be solved at the end, is reduced from  $N_x \times N_z$  for the initial 2D model to  $N_x \times M$  for the SDM method, where  $N_x$  and  $N_z$  are the number of grid points in the transport respectively confined direction, and  $M$  is the number of transversal modes taken into consideration. This leads to a considerable gain in the simulation time.

To summarize this method, Figure 3 presents a block diagram with the various levels of computation.

## 2.2 The WKB approximation

To reduce once more the numerical cost of the simulation, we improved the previous SDM model through the use of the WKB approximation. In the sequel we call this model SDM/WKB. The idea behind is to accelerate the resolution of the 1D Schrödinger equation (2.9), (2.13) by reducing the number of grid points in the transport direction. In this manner we will achieve an important gain in the computational time, as the 1D

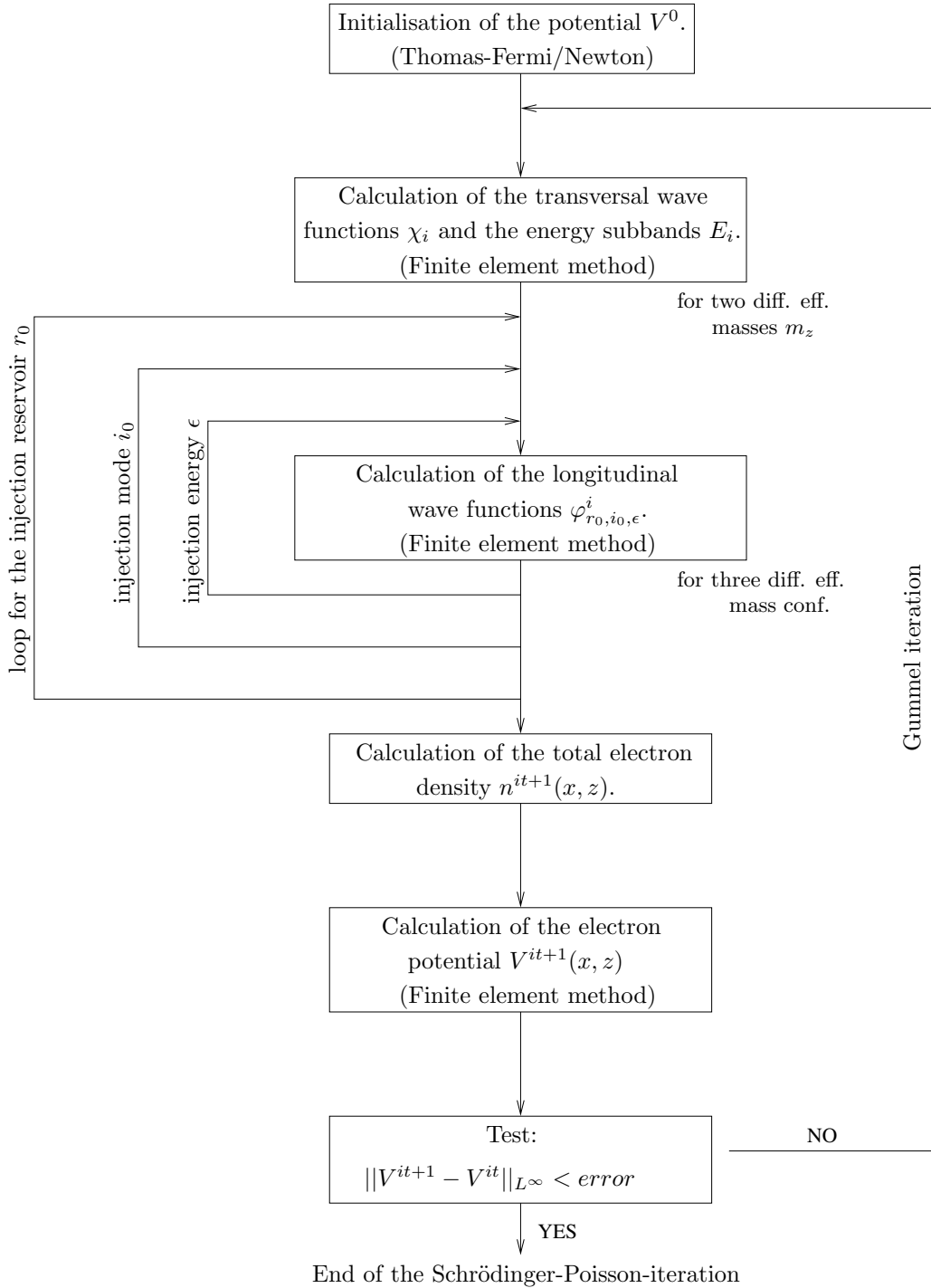


Figure 3: The SDM algorithm

Schrödinger equation has to be solved several times, one for each value  $\epsilon$  of the discretized energy spectrum. For this, remark that the high energy wave functions are strongly oscillating, and as such a refined mesh size is needed for the SDM model to accurately account for these functions. Indeed, the SDM approach uses finite elements, which consist in connecting nodal points by piecewise linear or polynomial approximation functions. The originality of the WKB approximation method is, that rather than using polynomial interpolation functions, oscillating interpolation functions are used, which incorporate a priori knowledge about the solution. Due to the fact, that the frequency of these oscillating functions is close to that of the wavefunction itself, this method permits to obtain accurate results with much coarser grids.

Starting from the coupled 1D Schrödinger equations (2.9) and considering only a finite number  $M$  of subbands, we can write this system under vectoriel form as

$$-\hbar^2\Phi''(x) - 2\hbar^2A(x)\Phi'(x) - \hbar^2B(x)\Phi(x) - C(x)\Phi(x) = 0, \quad x \in [a, b], \quad (2.18)$$

with  $\Phi := (\varphi_\epsilon^i)_{i=1}^M$ ;  $A := (a_{ij})_{i,j=1}^M$ ;  $B := (b_{ij})_{i,j=1}^M$  and  $C := (2c_{ij}(\epsilon - E_j))_{i,j=1}^M$ . The idea is to seek for an approximate solution of (2.18) in the form of a plane wave with a phase function  $S$  and modulated by an amplitude function  $\vec{e}$  as follows

$$\Phi(x) = e^{\frac{i}{\hbar}S(x)}\vec{e}(x), \quad \text{with} \quad \vec{e}(x) = \alpha(x)\vec{u}(x) \quad \text{and} \quad |\vec{u}(x)| = 1 \quad \forall x. \quad (2.19)$$

Inserting this Ansatz in (2.18) and neglecting terms in  $\hbar^2$ , yields

$$-2i\hbar S' \alpha' \vec{u} - 2i\hbar S' \alpha \vec{u}' - i\hbar S'' \alpha \vec{u} + (S')^2 \alpha \vec{u} - 2i\hbar S' \alpha A \vec{u} - \alpha C \vec{u} = 0.$$

The resolution of this equation is possible, if we consider the decomposition

$$\begin{cases} -2i\hbar S' \vec{u}' + (S')^2 \vec{u} - 2i\hbar S' A \vec{u} - C \vec{u} = 0, \\ 2S' \alpha' + S'' \alpha = 0. \end{cases} \quad (2.20)$$

Notice, that in the present 2D case,  $S$  and  $\vec{e}$  will depend on  $\hbar$ , which differs from the pure 1D case, investigated in [5]. The second equation of system (2.20) can be rewritten as

$$(S'_\hbar(\alpha_\hbar)^2)' = 0,$$

implying thus immediately for  $S'_\hbar \neq 0$

$$\alpha_\hbar(x) = \frac{c}{\sqrt{|S'_\hbar(x)|}}, \quad c \in \mathbb{C}.$$

In order to solve the first equation, we expand  $\vec{u}_\hbar$  and  $S_\hbar$  in powers of  $\hbar$

$$\vec{u}_\hbar(x) = \vec{u}^0(x) + \hbar \vec{u}^1(x) + \dots; \quad S_\hbar(x) = S^0(x) + \hbar S^1(x) + \dots. \quad (2.21)$$

Substituting these expansions in (2.20) and comparing the terms of the same order in  $\hbar$ , results in a sequence of equations to be solved to determine  $\vec{u}_\hbar^0$ ,  $\vec{u}_\hbar^1$ ,  $S_\hbar^0$ ,  $S_\hbar^1$ ,  $\dots$ . Limiting us to the zero<sup>th</sup> and first order terms, we obtain the equations

$$\left(\frac{d}{dx}S^0\right)^2(x)u^0(x) = C(x)u^0(x), \quad (2.22)$$

$$-2\mathbf{i}S^{0'}u^{0'} + (S^{0'})^2u^1 + 2S^{0'}S^{1'}u^0 - 2\mathbf{i}S^{0'}Au^0 - Cu^1 = 0. \quad (2.23)$$

For notational simplicity we omitted the index  $\hbar$  and the vector arrows. The matrix  $C$  is close to a real, diagonal matrix. This follows from (2.12) and the fact, that  $\chi_i \in H_0^1(0, 1)$  are orthogonal functions. From the perturbation theory we deduce that  $C$  is diagonalizable and has  $M$  simple, real eigenvalues  $\lambda_j(x)$ . Denote by  $u_j^0(x) \in \mathbb{R}^M$  the corresponding eigenvectors with  $|u_j^0(x)| = 1$ . Then we get from (2.22)

$$(S_j^{0'})'(x) = \begin{cases} \pm\sqrt{\lambda_j(x)} & \text{for } \lambda_j(x) \geq 0 \\ \pm\mathbf{i}\sqrt{|\lambda_j(x)|} & \text{for } \lambda_j(x) < 0 \end{cases}, \quad j = 1, \dots, M.$$

Let us denote by  $P$  the transformation matrix  $P(x) := (u_1^0(x) | \dots | u_M^0(x))$ , such that  $P^{-1}CP$  is the diagonal matrix containing the eigenvalues of  $C$ . Consider next a fixed transversal mode  $l \in \{1, \dots, M\}$  and let us compute the first order terms  $S_l^1, u_l^1$  corresponding to  $S_l^0$  and  $u_l^0$ . For this multiply (2.23) by  $P^{-1}$ , take the  $l$ -th coordinate and use (2.22). This leads to

$$S_l^{1'}(x) = \mathbf{i}\tilde{a}_{l,l}(x) + \mathbf{i}(P^{-1}u_l^{0'}(x))_l,$$

where  $\tilde{A} = P^{-1}AP$ . Taking the  $j$ -th coordinate, with  $j \neq l$ , we get

$$(P^{-1}u_l^1)_j(x) = 2\mathbf{i}\frac{S_l^{0'}(x)}{\lambda_l(x) - \lambda_j(x)} \left[ \tilde{a}_{jl}(x) + (P^{-1}u_l^{0'})_j \right].$$

To deduce  $u_l^1$ , remark that

$$u_l^1 = \sum_{j=1}^M \tau_j u_j^0 \quad \text{with} \quad \tau_j := (P^{-1}u_l^1)_j.$$

It remains thus to determine  $\tau_l$ . For this we shall take advantage of  $u_l^0 \cdot \mathcal{R}e u_l^1 = 0$ , fact which follows from the property  $|u_h(x)| = 1 \forall h$ . This implies

$$\mathcal{R}e \tau_l = 2\mathcal{I}m(S_l^{0'}) \sum_{j \neq l} \frac{1}{\lambda_l(x) - \lambda_j(x)} \left[ \tilde{a}_{jl}(x) + (P^{-1}u_l^{0'})_j \right] (u_j^0 \cdot u_l^0).$$

The imaginary part of  $\tau_l$  can be chosen arbitrary, leading thus to the expression of  $u_l^1$

$$u_l^1(x) = 2\mathbf{i}S_l^{0'} \sum_{j \neq l} \frac{1}{\lambda_l(x) - \lambda_j(x)} \left[ \tilde{a}_{jl}(x) + (P^{-1}u_l^{0'})_j \right] (u_j^0 - (u_j^0 \cdot u_l^0) u_l^0).$$

The numerical results however have shown that this part of the amplitude function increases only the simulation cost, without any gain in the accuracy of the approximate solution. For this reason and to simplify the following calculus, we shall omit  $u^1$  and stop the expansion (2.21) at the zero<sup>th</sup> order term  $u^0$ .

So far we can write an approximate solution of equation (2.18) in the form

$$\Phi(x) = T(x)\xi(x), \quad (2.24)$$

with

$$T(x) = \left( u_1^0(x) e^{-\int_{x_0}^x [\tilde{a}_{1,1}(t) + (P^{-1}u_1^{0'})_1] dt} | \dots | u_M^0(x) e^{-\int_{x_0}^x [\tilde{a}_{M,M}(t) + (P^{-1}u_M^{0'})_M] dt} \right),$$

and

$$\xi_j(x) = \begin{cases} \frac{c_j}{\sqrt[4]{\lambda_j(x)}} e^{\frac{i}{\hbar} \int_{x_0}^x \sqrt{\lambda_j(t)} dt} + \frac{d_j}{\sqrt[4]{\lambda_j(x)}} e^{-\frac{i}{\hbar} \int_{x_0}^x \sqrt{\lambda_j(t)} dt}, & \text{for } \lambda_j(\cdot) > \delta, \\ \frac{c_j}{\sqrt[4]{|\lambda_j(x)|}} e^{\frac{1}{\hbar} \int_{x_0}^x \sqrt{|\lambda_j(t)|} dt} + \frac{d_j}{\sqrt[4]{|\lambda_j(x)|}} e^{-\frac{1}{\hbar} \int_{x_0}^x \sqrt{|\lambda_j(t)|} dt}, & \text{for } \lambda_j(\cdot) < -\delta, \end{cases} \quad (2.25)$$

where  $c_j, d_j \in \mathbb{C}$  are constants and  $x_0$  is a reference point. These expressions are not valid close to a turning point  $\lambda_j(x) = 0$ . A threshold value  $\delta > 0$  was therefore introduced and the above solutions are expressed in intervals far from the turning points. This procedure will require a matching of WKB solutions, which are, each of them, valid in their respective regions.

As you can see from (2.25), we have essentially oscillating solutions in classically allowed regions and exponential solutions in classically forbidden regions. With the help of this formula, we shall construct now basis functions, which incorporate a priori knowledge about the solution. The aim is to create interpolation spaces with better approximation properties than the linear interpolation spaces, usually used in standard finite element methods. For this, let us discretize the interval  $[a, b]$  of the transport direction into several intervals  $I_n := (x_n, x_{n+1})$ . By straightforward algebraic computations, formula (2.25) can be rewritten in  $I_n$  in the form

$$\xi_j(x) = w_n^j(x) \xi_j^n + v_n^j(x) \xi_j^{n+1}, \quad \xi_j^n := \xi_j(x_n) \quad (2.26)$$

with

$$w_n^j(x) := \begin{cases} \alpha_n^j(x) f_n^j(x) & \text{for } |\lambda_j| \geq \delta \\ \frac{x_{n+1} - x}{x_{n+1} - x_n} & \text{for } |\lambda_j| < \delta \end{cases}; \quad v_n^j(x) := \begin{cases} \beta_n^j(x) f_{n+1}^j(x) & \text{for } |\lambda_j| \geq \delta \\ \frac{x - x_n}{x_{n+1} - x_n} & \text{for } |\lambda_j| < \delta, \end{cases}$$

$$\alpha_n^j(x) := \begin{cases} -\frac{\sin \sigma_{n+1}^j(x)}{\sin \gamma_n^j} & \text{for } \lambda_j \geq \delta \\ -\frac{\sinh \sigma_{n+1}^j(x)}{\sinh \gamma_n^j} & \text{for } \lambda_j \leq -\delta \end{cases}; \quad \beta_n^j(x) := \begin{cases} \frac{\sin \sigma_n^j(x)}{\sin \gamma_n^j} & \text{for } \lambda_j \geq \delta \\ \frac{\sinh \sigma_n^j(x)}{\sinh \gamma_n^j} & \text{for } \lambda_j \leq -\delta, \end{cases}$$

$$\sigma_n^j(x) := \frac{1}{\hbar} \int_{x_n}^x \sqrt{|\lambda_j(t)|} dt; \quad \gamma_n^j := \frac{1}{\hbar} \int_{x_n}^{x_{n+1}} \sqrt{|\lambda_j(t)|} dt; \quad f_n^j(x) := \sqrt[4]{\frac{|\lambda_j(x_n)|}{|\lambda_j(x)|}}.$$

In the neighborhood of a turning point, we have matched the different WKB approximations by linear interpolation functions. This can be explained by looking at the pure 1D case, where the second derivative of the wave function  $\varphi''$  vanishes at a turning point, implying thus a linear evolution of  $\varphi$  close to this point. The functions  $\alpha_n^j$  and  $\beta_n^j$  are the so-called WKB basis functions. These are highly oscillating functions, with a frequency close to that of the wave function, which is given by

$$\lambda_{\epsilon,i}(x) = \frac{2\pi\hbar}{\sqrt{2m_x(\epsilon - E_i(x))}}.$$

In the limit  $\Delta x \ll \lambda$  they reduce to the usual linear interpolation functions. Figure 4 compares a “hat-function” constructed with the WKB basis functions and a standard linear hat-function.

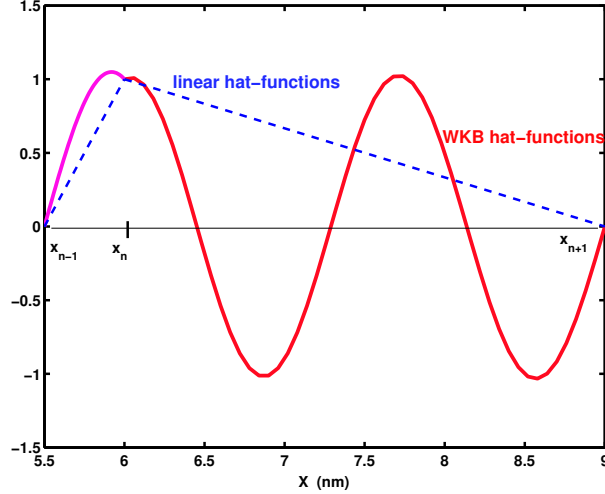


Figure 4: A WKB hat-function and a standard linear hat-function on an irregular grid.

Arrived at this stage, we possess an appropriate finite dimensional approximation space. The procedure now is to project the investigated solution of (2.18) by means of (2.24) and (2.26) on this space and to choose a discretization method in order to get a scheme for the unknown values  $\xi^n$ . The method used in this paper is the finite difference method deduced by integrating (2.18) in  $(x_{i-1/2}, x_{i+1/2})$

$$\Phi'(x_{n+1/2}) - \Phi'(x_{n-1/2}) = -2 \int_{x_{n-1/2}}^{x_{n+1/2}} A(x)\Phi'(x)dx - \int_{x_{n-1/2}}^{x_{n+1/2}} \left( B(x) + \frac{1}{\hbar^2}C(x) \right) \Phi(x)dx. \quad (2.27)$$

Replacing in this equation  $\Phi$  and its derivatives by the projections in the WKB approximation space, yields a numerical scheme in the unknowns  $\xi_j^n$ . Close to the boundary we consider the intervals  $[x_1, x_{1+1/2}]$  respectively  $[x_{N-1/2}, x_N]$  and include the following boundary conditions into the corresponding expressions

$$\begin{cases} \Phi'(x_1) = D\Phi(x_1) + v_a \\ \Phi'(x_N) = E\Phi(x_N) + v_b, \end{cases}$$

with

$$D := \begin{pmatrix} -\mathbf{i}k_{x,1}^a \delta_{1 \leq I_a} + k_{x,1}^a \delta_{1 > I_a} & & 0 \\ & \ddots & \\ 0 & & -\mathbf{i}k_{x,M}^a \delta_{M \leq I_a} + k_{x,M}^a \delta_{M > I_a} \end{pmatrix}; \quad v_a := 2\mathbf{i}(k_{x,i}^a \alpha_{i,\epsilon}^a)_{i=1}^M,$$

and

$$E := \begin{pmatrix} \mathbf{i}k_{x,1}^b \delta_{1 \leq I_b} - k_{x,1}^b \delta_{1 > I_b} & & 0 \\ & \ddots & \\ 0 & & \mathbf{i}k_{x,M}^b \delta_{M \leq I_b} - k_{x,M}^b \delta_{M > I_b} \end{pmatrix}; \quad v_b := -2\mathbf{i}(k_{x,i}^b \alpha_{i,\epsilon}^b)_{i=1}^M.$$

The resulting block tridiagonal linear system is solved by standard methods.

### 2.3 Comparison of the two methods: SDM and SDM/WKB

In order to show the efficiency of the new method, an extensive comparison between the SDM and the SDM/WKB method has been performed for the case of a MOSFET with a  $5\text{ nm}$  large and  $10\text{ nm}$  long channel. A reference solution was computed using the SDM method on a very fine mesh ( $N_x = 540$ ,  $N_z = 210$ ) and the results obtained with the two methods SDM and SDM/WKB on various fine/coarse meshes are compared with this reference solution, according to accuracy and simulation time.

In Figure 5 (a) a plot of the sheet charge density versus  $x$  obtained with the SDM/WKB method on a grid of  $N_x \times N_z = 13 \times 60$  points (full line) is compared to the analogous plot of the reference solution (broken line). Figure 5 (b) represents the corresponding cross-sections of the potential energy along the channel, near the  $Si/SiO_2$  interface. As one can observe, the agreement between full lines and broken lines is satisfactory, the SDM/WKB method reproduces quite well the macroscopic quantities, as the charge density and the potential energy.

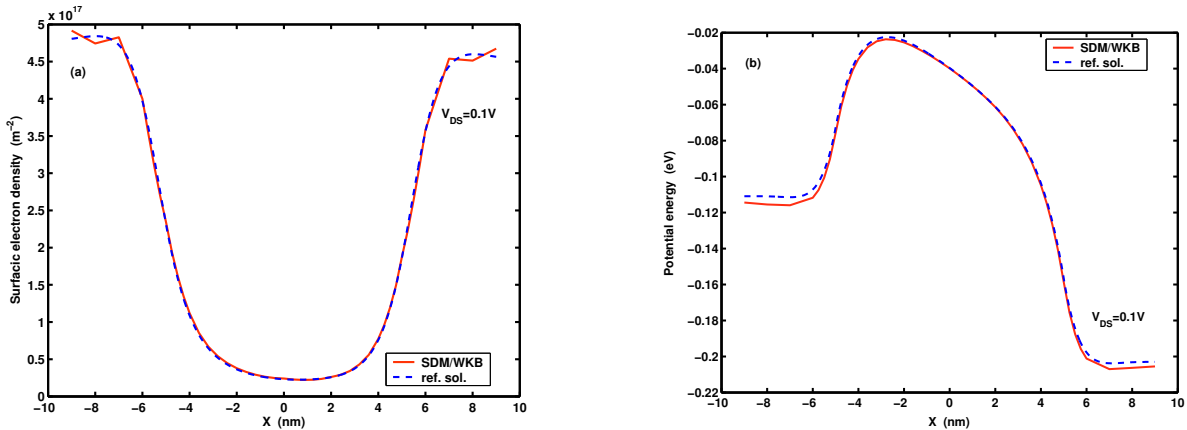


Figure 5: (a) Plot of the sheet charge density for  $V_{GS} = 0.1V$  and  $V_{DS} = 0.1V$ . Full lines: SDM/WKB ( $13 \times 60$  points); Broken lines: reference solution. (b) Cross sections of the potential energy at  $1\text{nm}$  from the interface  $Si/SiO_2$  for  $V_{GS} = 0.1V$  and  $V_{DS} = 0.1V$ .

To illustrate more precisely the efficiency of the SDM/WKB method, we plot in Figure 6 the pointwise relative errors of both methods (with respect to the reference solution) and this for the sheet charge density and the potential energy represented above. The grids chosen for the presented results consist of  $13 \times 60$  points for the SDM/WKB method and  $72 \times 60$  points for SDM. These grids were selected in such a manner to get similar relative errors for the two different methods, more or less 5%, so that we can compare the corresponding simulation times. We observe that for approximately the same precision, the simulation time is significantly reduced with the SDM/WKB method by a factor of about 2 compared to SDM. More details about the gain in the simulation time can be extracted from Table 1. The total simulation time corresponds to

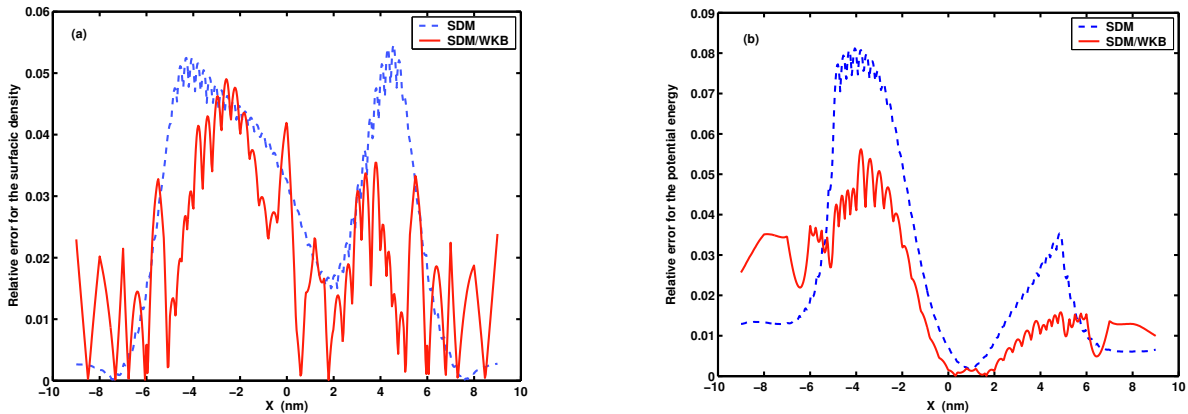


Figure 6: Relative errors of the SDM ( $72 \times 60$  points) resp. SDM/WKB ( $13 \times 60$  points) methods with respect to the reference solution, for the (a) sheet charge density,  $V_{GS} = 0.1V$ ,  $V_{DS} = 0.1V$ ; (b) potential energy at  $1nm$  from the interface  $Si/SiO_2$ ,  $V_{GS} = 0.1V$ ,  $V_{DS} = 0.1V$ .

the computation of a current-voltage characteristic for a fixed gate potential  $V_{GS}$ , that means the Schrödinger-Poisson system is solved several times, for 11 different drain-source potentials  $V_{DS} = 0V, \dots, 0.5V$ .

	Nbr. grid pts. in $x$	Total sim. time	Poisson eq.	Eigenval. problem	Schrödinger 1D $1 \times (j_0, r_0, k_x)$	Schrödinger 1D total
SDM	72	89 min 32 s	0.04s	0.01s	0.05s	86s
WKB	13	46 min 28 s	0.02s	0.01s	0.03s	42s

Table 1: Comparison of the simulation times of SDM and SDM/WKB.

It is of interest to notice, that the most time consuming part of the simulation is the resolution of the total 1D Schrödinger equation. This is a consequence of the fact, that the 1D longitudinal Schrödinger equation (2.9) has to be solved several times, one for each injection configuration  $(j_0, r_0, \epsilon)$ . Thus it is not surprising, that reducing via the WKB approximation the computational time for the resolution of a single Schrödinger equation, leads to a considerable gain in the total simulation time.

Let us now compare the accuracy and the simulation time of the two considered methods for the same mesh. We represent in the following two figures the relative errors for the surfacic density obtained with the SDM/WKB method (Fig. 7 (a)) respectively with the SDM method (Fig. 7 (b)) for various meshes, the relative error being computed with respect to the reference solution. Table 2 gives the corresponding total simulation times for the two methods, dependent on the number of grid points in the  $x$ -direction. For example, on a mesh of  $13 \times 60$  points the SDM/WKB method is 9 times more accurate than the SDM method, but 3 times less rapid. Generally we can say that for the same mesh, the SDM method is less accurate but faster than the SDM/WKB method.

To conclude, the WKB approximation has been successfully used in a SDM method to further reduce computation time and allow extensive simulation of 2D quantum

transport in nanoscale MOSFETs.

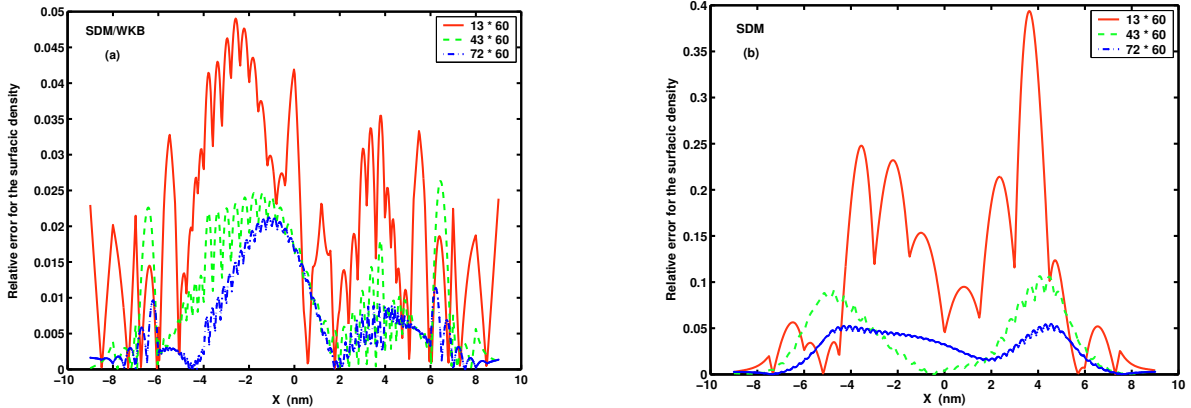


Figure 7: Relative errors for the sheet charge density obtained with the two methods SDM/WKB (a) and SDM (b) as compared to the reference solution, for different meshes and the potential configuration  $V_{GS} = 0.1V$ ,  $V_{DS} = 0.1V$ .

$N_x \times N_z$	Total sim. time SDM/WKB	Total sim. time SDM
$13 \times 60$	46 min 28 s	17 min 21 s
$43 \times 60$	155 min 58 s	35 min 57 s
$72 \times 60$	305 min 3 s	89 min 32 s

Table 2: Comparison of the total simulation times of SDM and SDM/WKB for different meshes.

### 3 Some numerical considerations and problems

We shall discuss in this section some points that have to be considered with a certain attention in the implementation of the SDM/WKB method. Other interesting remarks concerning the resolution of the Poisson equation, the linearization of the coupled Schrödinger-Poisson system by means of the Gummel iteration, the initial guess of the electrostatic potential, etc. can be found in [6], since this steps of the algorithm are common to both SDM and SDM/WKB models.

(1) Table 1 shows that a mesh of 13 grid points in the transport direction is used for the resolution of the 1D coupled Schrödinger equations (2.9). However, in order to compute accurately the derivatives of the transversal wavefunctions  $\chi_i$  with respect to  $x$ , needed for the computation of the coupling terms (2.10), (2.11) and the current density (2.16), we have to introduce a second mesh in the transport direction, which is much finer. Thus we are let to use two different discretizations of this direction. The eigenvalue problem (2.8) shall be solved for each “parameter”  $x$  belonging to the fine grid (43 grid

points in our algorithm), whereas the Schrödinger equations (2.9) are solved on the coarser grid (13 grid points). It remains to interpolate the results from the coarse grid to the fine one. For this, we remark that once we have solved the tridiagonal linear system corresponding to the discretization scheme (2.27), in order to deduce the values  $\xi^n$  at the coarse grid nodal points, we can determine by means of (2.24) and (2.26) the values of the wavefunction and of its derivatives anywhere in the interior of a coarse grid interval. In this manner we obtain the charge density and consequently the electrostatic potential on the fine mesh in order to restart the Schrödinger-Poisson iteration. This “multigrid” procedure enables to exploit the advantages of the WKB approximation for the resolution of (2.9), which were mentioned in the previous section, without loosing at the same time on precision for other computations, as for example for the derivation of the transversal wavefunctions with respect to  $x$ . Note moreover, that the eigenvalue problem (2.8) is solved only few times in a Schrödinger-Poisson loop (two times for a fixed parameter  $x$ ), in contrast to the 1D Schrödinger equations, which have to be solved several times, one for each electron injection energy. For this reason, the just described procedure does not increase much the computational cost.

(2) The choice of the “multigrid” strategy in the transport direction, mentioned in the first point, has also another reason. The fine grid is not only necessary for the derivation of the transversal wavefunctions  $\chi_i$ , but also for the regularity with respect to the  $x$ -direction of the first two transversal waves  $\chi_1^{m_l}$  and  $\chi_2^{m_l}$ , corresponding to the heavy effective mass  $m_l$  in the confinement direction.

Indeed the particularity of the first two subbands associated to  $m_l$  is that they are very close (see Figure 11). Consequently the computer treats them as a double eigenvalue, such that the corresponding eigenvectors  $\chi_1^{m_l}$  and  $\chi_2^{m_l}$  are chosen arbitrarily as orthonormal eigenvectors of a 2D eigenspace. These so obtained eigenvectors can be rather different from the correct ones, corresponding to the two separate eigenvalues. In [6] a numerical procedure was introduced to cope with this failure. This procedure consists in the following steps. Starting from a point  $x_j$  with given  $\chi_1^{m_l}(z; x_j)$  and  $\chi_2^{m_l}(z; x_j)$ , we compute independently  $\widehat{\chi}_1^{m_l}(z; x_{j+1})$  and  $\widehat{\chi}_2^{m_l}(z; x_{j+1})$  by solving (2.8) at  $x_{j+1}$ . Then we rotate these so obtained eigenvectors in such a manner to get the regular wavefunctions  $\chi_1^{m_l}$  and  $\chi_2^{m_l}$  in the  $x$ -direction. In other words, we obtain the new  $\chi_1^{m_l}(z; x_{j+1})$  and  $\chi_2^{m_l}(z; x_{j+1})$  by the following rotation

$$\begin{pmatrix} \chi_1(z; x_{j+1}) \\ \chi_2(z; x_{j+1}) \end{pmatrix} = \begin{pmatrix} \cos(\theta) & \sin(\theta) \\ -\sin(\theta) & \cos(\theta) \end{pmatrix} \begin{pmatrix} \widehat{\chi}_1(z; x_{j+1}) \\ \widehat{\chi}_2(z; x_{j+1}) \end{pmatrix},$$

with the rotation angle  $\theta$  chosen so that  $\chi_1(z; x_{j+1})$  (resp.  $\chi_2(z; x_{j+1})$ ) is close to  $\chi_1(z; x_j)$  (resp.  $\chi_2(z; x_j)$ ). This leads to the condition

$$\int_0^1 \chi_1(z; x_{j+1})\chi_2(z; x_j)dz = 0,$$

implying

$$\tan(\theta) = -\frac{\int_0^1 \widehat{\chi}_1(z; x_{j+1})\chi_2(z; x_j)dz}{\int_0^1 \widehat{\chi}_2(z; x_{j+1})\chi_2(z; x_j)dz}.$$

It is now obvious that in order to get a precise rotation angle  $\theta$ , we need a fine mesh in the  $x$ -direction.

Another point to be treated with care in the just recalled numerical procedure is the choice of the starting point  $x_*$ . It is convenient to begin at a point  $x_*$ , at which the first two eigenvalues  $E_1^{m_i}(x_*)$  and  $E_2^{m_i}(x_*)$  are the most distant possible. This occurs rather in the middle of the interval, as can be observed in Figure 11, so that starting from this point, we shall carry out the rotation technique stepwise to the left and to the right.

(3) This point concerns the truncation of the injection energy integral in the calculus of the charge density (2.14) and current density (2.16). The upper limit of the electron injection energy  $\epsilon$  is fixed at a temperature of  $T = 300K$  to  $E_{sup} = E_F^r + 4k_B T$  for gate potentials  $V_{GS} \geq 0V$ . Here we denoted by  $E_F^r$  the Fermi level of the source reservoir if  $r = a$  or drain reservoir if  $r = b$ . In the case of  $V_{GS} \geq 0V$ , the number of particles injected with an energy superior to  $E_{sup}$  is very small compared to the number of particles contributing to the electron current and can thus be neglected. This comes from the fact, that the Fermi-Dirac statistic is very small if  $E - E_F > 4k_B T$ . Indeed, we have for  $E - E_F > 4k_B T$

$$f_{FD}(E) = \frac{1}{1 + \exp\frac{E-E_F}{k_B T}} \leq \frac{1}{1 + e^4} \sim e^{-4} = 1.8 \cdot 10^{-2} \ll 1.$$

However for gate potentials inferior to  $0V$  the number of particles contributing to the electron transport by thermionic emission or quantum tunneling is rather small so that the contribution of the particles injected with an energy superior to  $E_F^r + 4k_B T$  becomes significant. The size of the injection energy interval has thus to be adjusted to the gate potential and it is necessary to consider larger injection energy intervals for  $V_{GS} < 0V$ . Numerically we determined the upper energy limit for a fixed  $V_{GS} < 0V$ , by comparing the obtained currents (at  $V_{DS} = 0.5V$ ) for different  $E_{sup}$ . The upper limit  $E_{sup}$  is increased until the changes in the current become negligible (relative error of 5%). The values determined by this manner are shown in Table 3.

$V_{GS}$	$0V$	$-0.1V$	$-0.2V$	$-0.3V$
$E_{sup}$	$E_F^r + 4k_B T$	$E_F^r + 6k_B T$	$E_F^r + 8k_B T$	$E_F^r + 10k_B T$

Table 3: Upper electron injection energy limits for different gate potentials.

As an example, Figure 8 illustrates the current versus gate potential characteristic obtained with a fixed maximal injection energy of  $E_{sup} = E_F^r + 4k_B T$  (broken line) and that one obtained with the values of Table 3 (full line). Remark that the difference between the two characteristics is significant.

It is important to remark, that increasing the maximal electron injection energy, one has to verify if the number of subbands taken into consideration is large enough. Tests have shown that the choice of  $M = 12$  subbands is sufficient even for  $E_{sup} = E_F^r + 10k_B T$ .

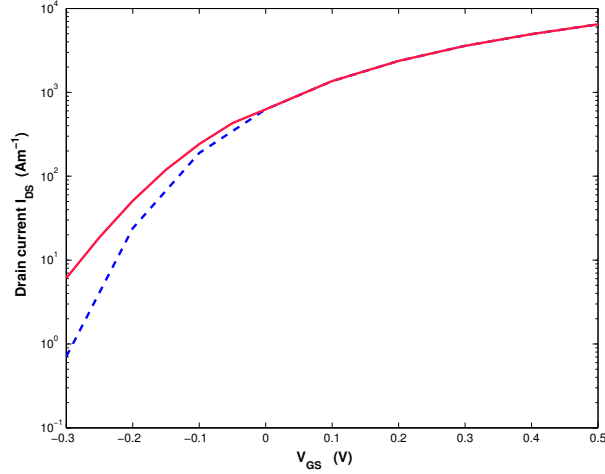


Figure 8: Current versus gate potential characteristics in log. scale, for  $V_{DS} = 0.5V$ . Full line: The maximal injection energy  $E_{sup}$  is rectified with respect to  $V_{GS}$  as given in Table 3. Broken line:  $E_{sup}$  is fixed to  $E_F^r + 4k_B T$ .

## 4 Discussion of the numerical results obtained with SDM/WKB

### 4.1 Parameters for the considered MOSFET

The various parameters describing the structure of the simulated double gate MOSFET, illustrated in Figure 9, are presented in Table 4.

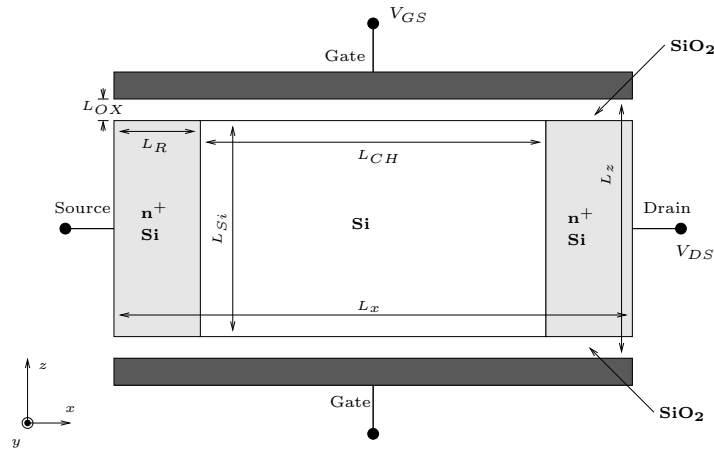


Figure 9: The DG NMOSFET.

Parameter	Value	Parameter	Value
$L_x$	$18nm$	$m_l$	$0.98 * m_e$
$L_z$	$12nm, 7nm, 5nm$	$m_t$	$0.19 * m_e$
$L_{OX}$	$1nm$	$T$	$300 K$
$L_{Si}$	$10nm, 5nm, 3nm$	$n^+$	$10^{20} cm^{-3}$
$L_R$	$4nm$	$V_{GS}$	$-0.3, \dots, 0.5 eV$
$L_{CH}$	$10nm$	$V_{DS}$	$0, \dots, 0.5 eV$
$m_{SiO_2}$	$0.5 * m_e$	$E_C$	$3.15 eV$

Table 4: Specifications of the modeled device.

## 4.2 Analysis of the $10nm \times 10nm$ MOSFET

We present in this section the essential simulation results of the  $10nm \times 10nm$  MOSFET transistor, obtained with the SDM/WKB model, and analyze these results from a physical point of view.

In the ballistic regime, the MOSFET schematically operates as follows (Figure 10): Electrons are injected from the two thermal equilibrium reservoirs (the source and the drain) across a potential energy barrier. Electrons having an energy higher than this energy barrier, are transmitted from the source to the drain or inversely by thermionic emission, whereas electrons with a smaller energy can pass only by quantum mechanical tunneling. The gate voltage modulates the height of this potential barrier.

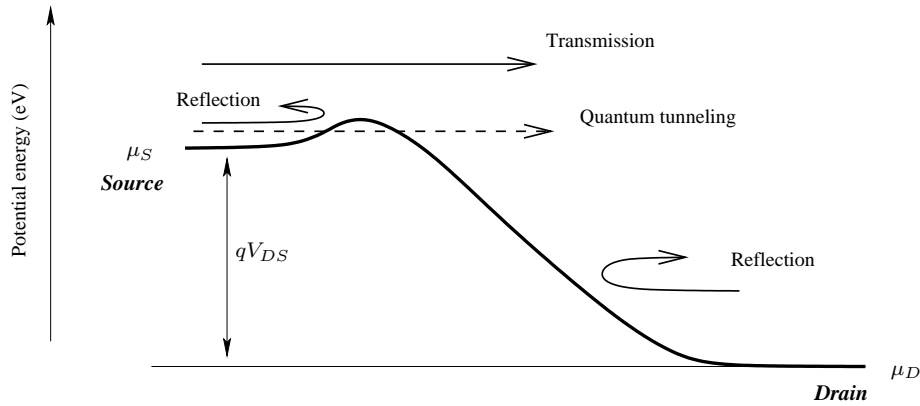


Figure 10: Schematic mechanism of a MOSFET.

Due to the anisotropic nature of the conduction band of *Si*, the energy discretization in the confinement direction results in two sets of subbands, associated to two different effective mass values. The lower subbands (and thus firstly populated) are associated with the heavy longitudinal effective mass  $m_l$  in the confined direction  $z$ , and the higher ones are associated with the lighter transversal effective mass  $m_t$  in direction  $z$  (Fig. 11).

Note that the subbands are closely spaced if the Silicon film is thick, and as such several

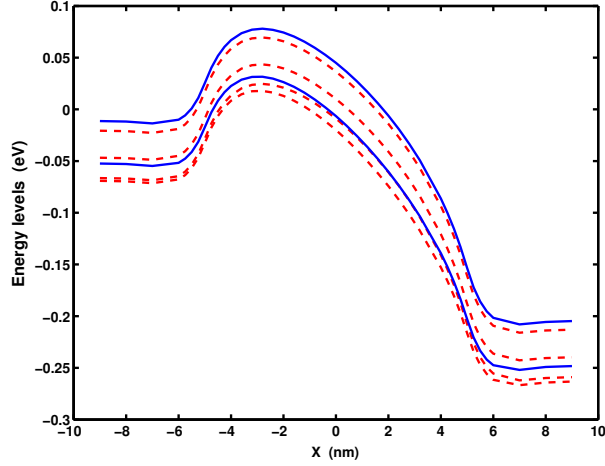


Figure 11: Conduction energy subbands for  $V_{DS} = 0.2V$  and  $V_{GS} = 0V$ . The full lines correspond to the first two energy subbands associated to  $m_t$  (primed subbands), whereas the broken lines are the first four energy subbands associated to  $m_l$  (unprimed subbands).

subbands have to be taken into account in the model, in order to simulate correctly the electron transfer within the device. In particular, the first two subbands associated to  $m_l$  are very close, fact which requires a slightly different numerical procedure for the determination of the corresponding transversal waves  $\chi_1^{m_l}$ ,  $\chi_2^{m_l}$  (see Section 3 and [6]). Figure 12 illustrates the profile of the first  $m_t$ -subband for different drain-source respectively different gate voltages.

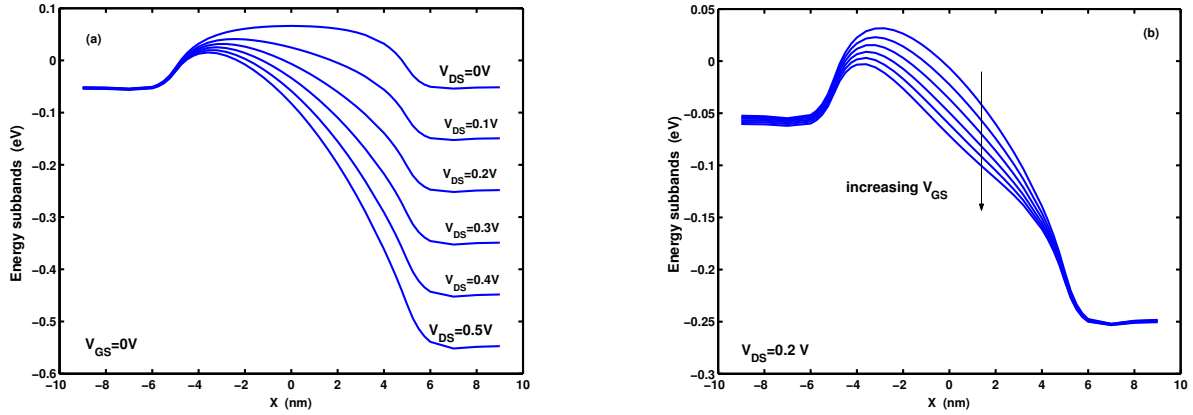


Figure 12: Subband deformation with the variation of the drain-source voltage (a) respectively gate voltage (b). Represented is the first  $m_t$ -subband.

Figure 13 represents the electron density and potential energy of the examined MOSFET ( $V_{DS} = 0.5V$ ,  $V_{GS} = 0.1V$ ). The energy potential barrier between source and channel is visible. With a  $10\text{ nm}$   $Si$  thickness, the lower potential energy near the the  $Si/SiO_2$  interface induces the formation of two inversion layers, where the electron density is more raised. The gate potential  $V_{GS}$  modulates the height of this barrier and thus the number

of free electrons in the channel. For transistors with ultrathin *Si*-bodies ( $< 3nm$ ), the two inversion layers merge to a single one, as it will be discussed in Section 4.3.

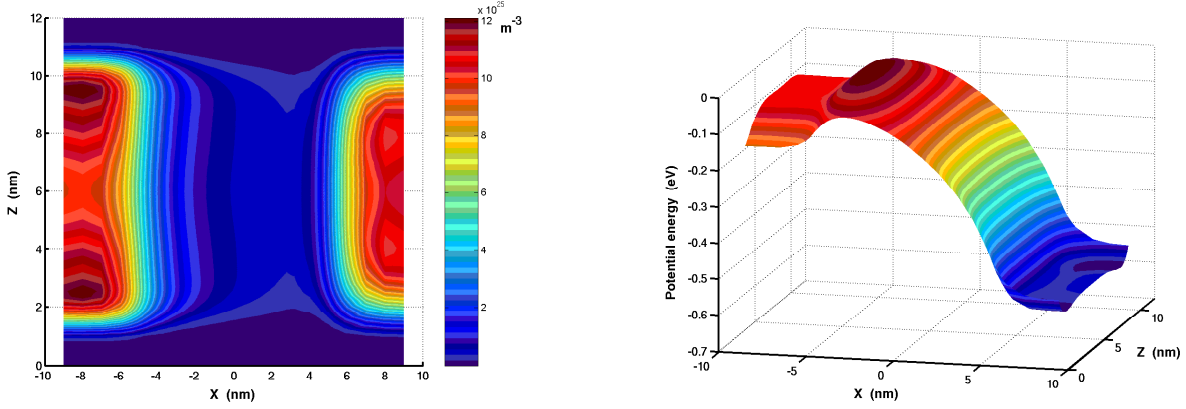


Figure 13: Electron density (left) and potential energy (right) for  $V_{DS} = 0.5V$  and  $V_{GS} = 0.1V$ .

Figure 14 shows cross sections of the charge density and potential energy for various values of the drain-source potential and for a fixed gate potential. Remark the influence of the drain-source potential on the length of the potential barrier. As the drain bias voltage  $V_{DS}$  increases, the source barrier shrinks not only in height, measured by the DIBL (Drain Induced Barrier Lowering), but also in length. This implies a higher contribution of the tunneling charge to the drain current  $I_{DS}$ .

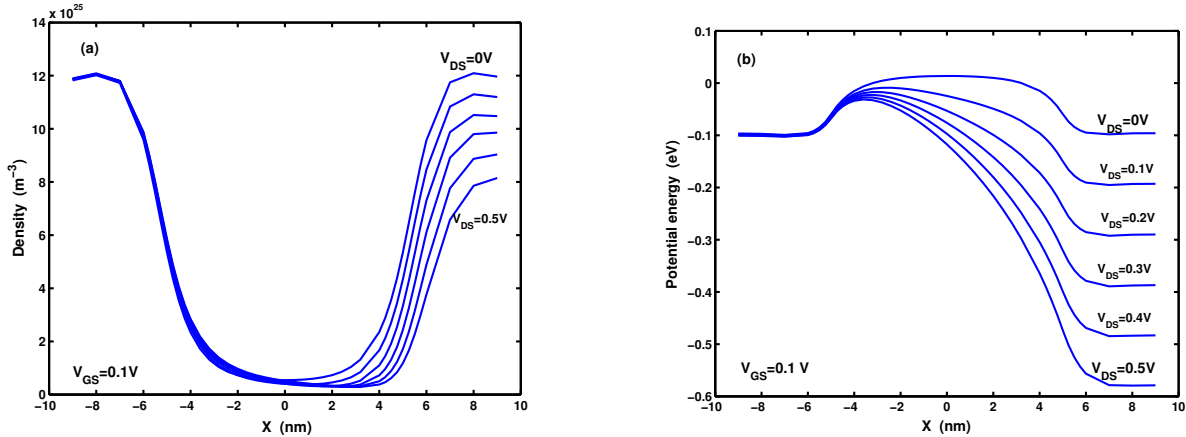


Figure 14: Cross sections of the electron density (a) respectively potential energy (b) at  $1nm$  from the interface *Si/SiO<sub>2</sub>* for  $V_{GS} = 0.1V$  and various drain-source potentials  $V_{DS}$ .

The current density is presented in Figure 15. Note the existence of the two channels close to the device/oxide interface (double channel conduction) (Fig. 15 (right)). In Figure 15 (left), which differs from the right figure by the value of the gate potential, one can observe the pinch-off point near the end of the channel. At this point the electrostatic potential equals the saturation potential  $V_{sat} = V_{GS} - V_T$ , where  $V_T$  is

the threshold voltage. In the region beyond this point conduction is moved from the interfaces to the volume of the film. With the increase of the drain bias  $V_{DS}$ , the pinch-off point moves towards the source.

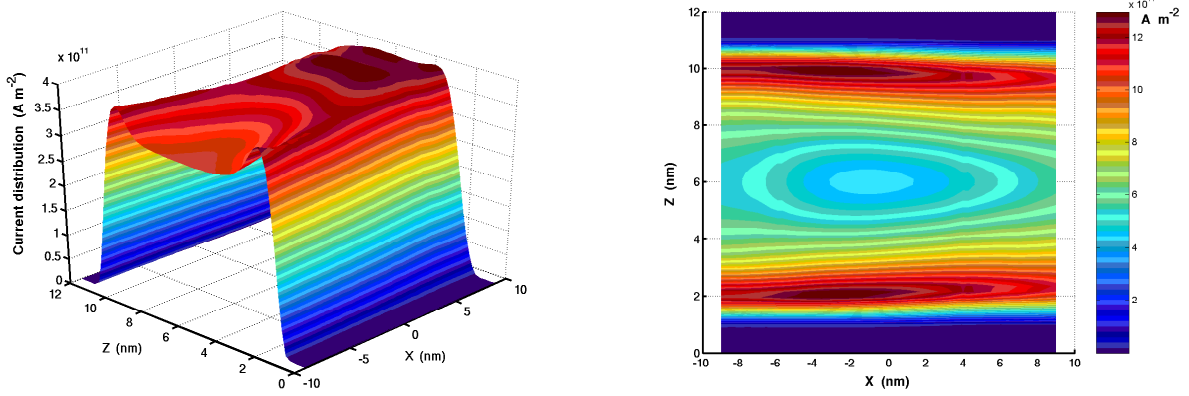


Figure 15: Distribution of the current density for  $V_{GS} = 0.1V$  and  $V_{DS} = 0.5V$  (left) respectively  $V_{GS} = 0.5V$  and  $V_{DS} = 0.5V$  (right).

It has been checked, that the current given by

$$I_{DS}(x) = \int_0^1 j(x, z) \cdot \begin{pmatrix} 1 \\ 0 \end{pmatrix} dz,$$

is constant along the MOSFET. I-V characteristics are shown in Figure 16. As expected with an aspect ratio of 1 between channel length and film thickness, rather large short channel effects are observed (large DIBL and low  $g_m/g_d$ ). As the channel length of the modeled device is rather short ( $< 1\mu m$ ), the drain current  $I_{DS}$  increases slowly with  $V_{DS}$  beyond the saturation value  $I_{sat}$ , such that no saturation can be observed.

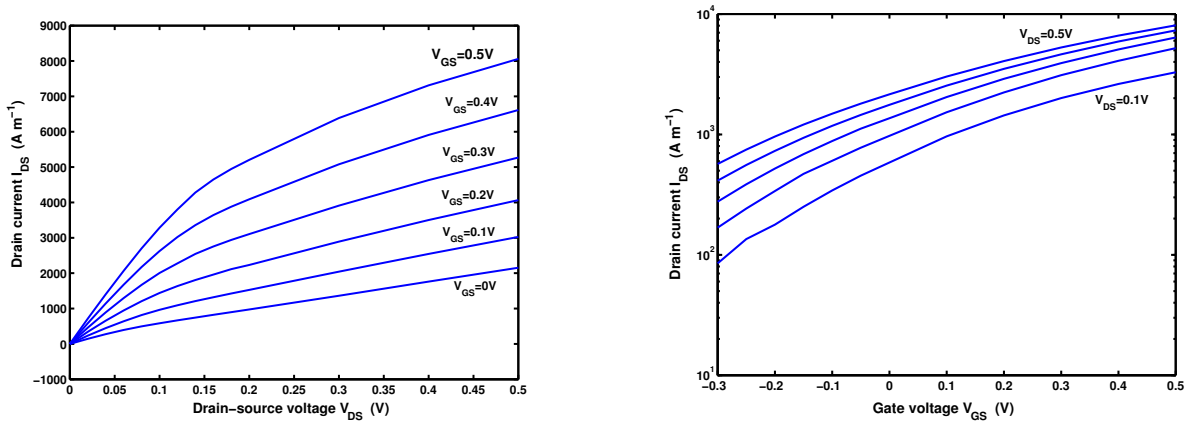


Figure 16: Current-Voltage characteristics. Left: Current versus drain-source potential  $V_{DS}$ . Right: Current versus gate potential  $V_{GS}$  in logarithmic scale.

The repartition of the charge density, average velocity and current density between the three valley orientations shows interesting features as both the spatial variations

and the amplitudes are affected by the valley orientations. Electrons occupying the lower subbands (configuration  $m_{lz}$ : electrons respond with the longitudinal effective mass in the direction  $z$ ) are highly localized against the interface and are much more numerous, whereas the electrons corresponding to the configurations  $m_{lx}$  and  $m_{ly}$  are less confined and in smaller number than the first ones. Due to the different effective masses in the transport direction, the electrons have also different velocities. Electrons characterized by the heavy effective mass in the transport direction (configuration  $m_{lx}$ ) are less rapid compared to those characterized by the light effective mass in this direction (configurations  $m_{ly}$  and  $m_{lz}$ ). This results in a different contribution to current, both in absolute value and spatial distribution, for the three valley orientations.

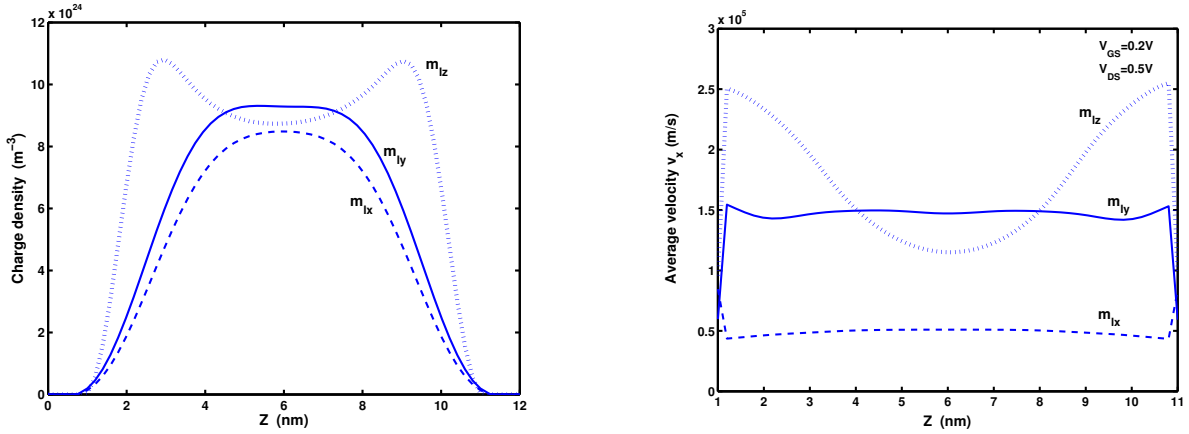


Figure 17: Cross sections of the charge density (left) and the  $x$ -component of the average velocity  $\vec{v}_x$  (right) close to the drain, for  $V_{GS} = 0.2V$  and  $V_{DS} = 0.5V$ . Represented are the plots for the three different mass configurations.

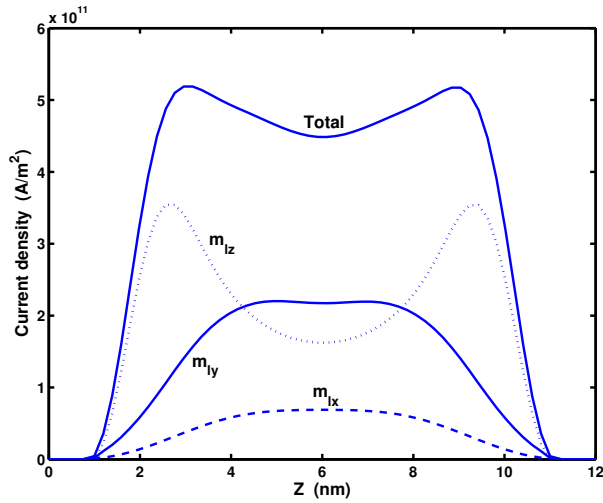


Figure 18: Cross sections of the current density  $\vec{j}_x$ , corresponding to the three different effective mass configurations and taken close to the drain.  $V_{GS} = 0.2V$ ;  $V_{DS} = 0.5V$ .

Figure 19 illustrates how the average velocity increases with the applied drain-source potential  $V_{DS}$ .

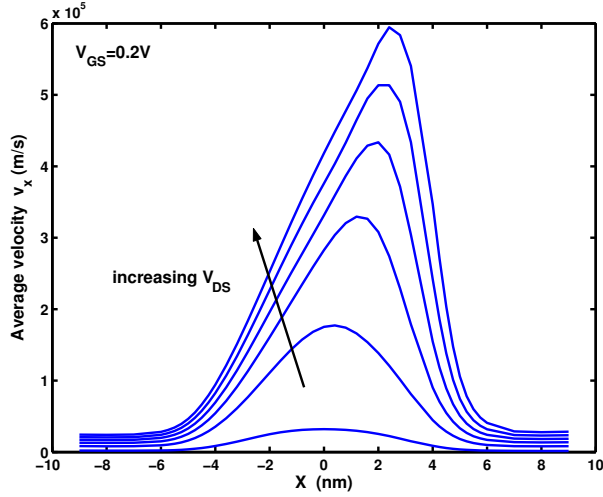


Figure 19: Profiles of the average velocity  $\vec{v}_x$  versus position, for different drain-source voltages and fixed  $V_{GS} = 0.2V$ .

A 2D plot of the kinetic energy and average velocity (in the transport direction) is presented in Figure 20.

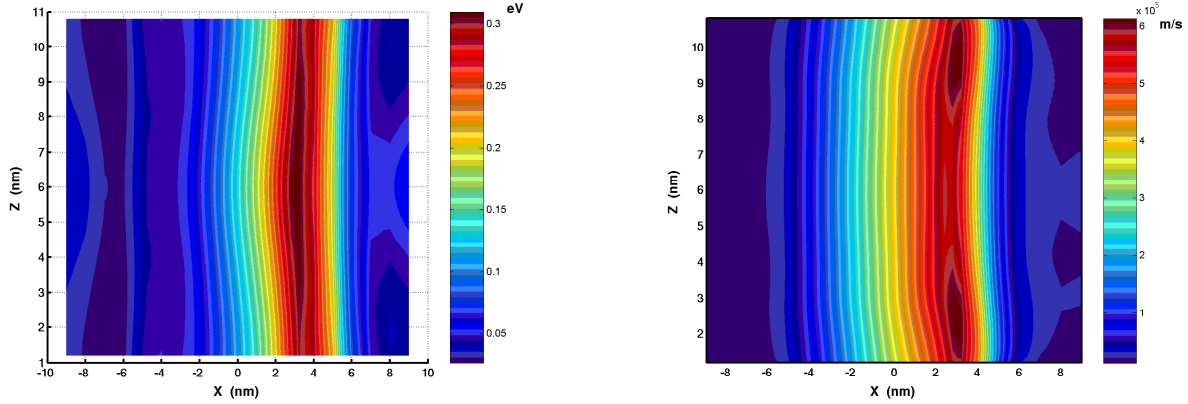


Figure 20: 2D plots representing the  $x$ -component of the electron kinetic energy (left) respectively average velocity (right), for  $V_{DS} = 0.5V$  and  $V_{GS} = 0.1V$ .

### 4.3 Influence of the Silicon thickness

We will devote this section on the comparison of MOSFET devices with different body thicknesses.

Figure 21 shows cross sections of the charge density for three different body thicknesses. As the transistor body gets thinner, the two inversion layers progressively merge into only one inversion region in the volume of the silicon film (volume inversion). Although

the peak density gets higher as body thickness decreases, the integrated charge is reduced. This is consistent with the well known threshold shift induced by quantum confinement.

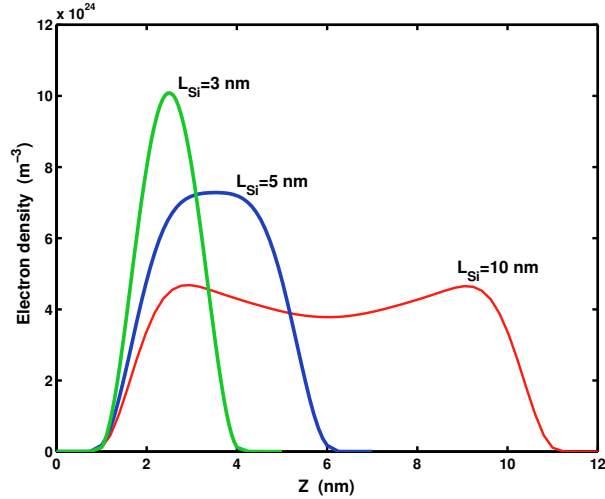


Figure 21: Cross sections of the electron density in the middle of the device ( $X = 0nm$ ) for different body thicknesses and for  $V_{GS} = 0.1V$  and  $V_{DS} = 0.1V$ .

For thinner films, the spacing between energy subbands increases so that fewer subbands need to be simulated. Figure 22 shows the electron occupancy of the subbands for the three compared devices, where we summed over the three valley orientations. It can be observed that in very thin devices a one subband approximation is sufficiently accurate.

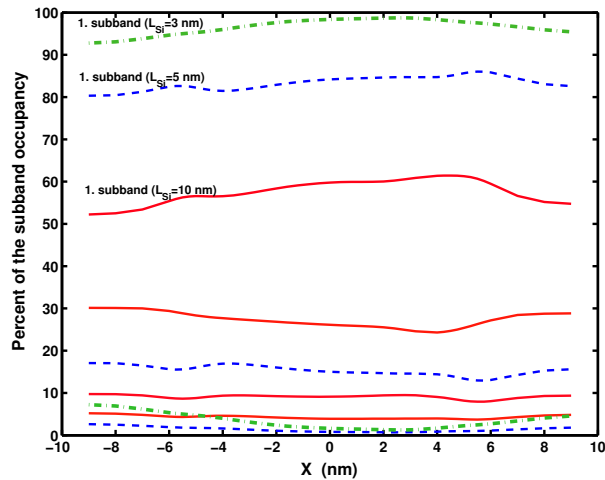


Figure 22: Percentage of the subband occupancy for the three different body thicknesses. The full lines represent the  $10nm$  large MOSFET, the broken lines the  $5nm$  and the broken-dotted lines the  $3nm$  device.  $V_{GS} = 0V$ ,  $V_{DS} = 0.2V$ .

Finally, the influence of body thickness on I-V characteristics is shown in Figure 23.

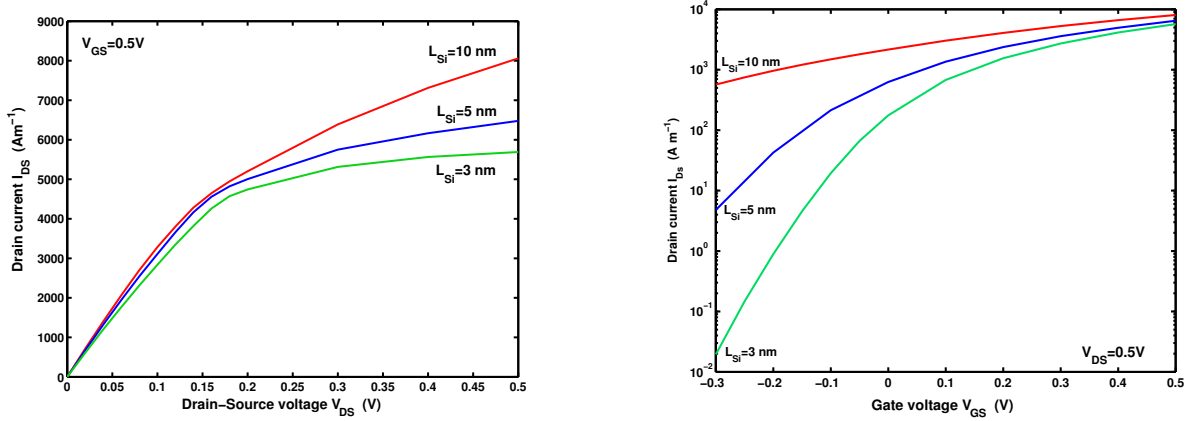


Figure 23: Comparison of the characteristics for the three different body thicknesses. Left: Current versus drain-source potential  $V_{DS}$ , for  $V_{GS} = 0.5V$ ; Right: Current versus gate potential  $V_{GS}$ , for  $V_{DS} = 0.5V$  (log. scale).

#### 4.4 The tunneling effect

The two methods, SDM/WKB as well as SDM, have the advantage of accounting for quantum effects in both directions, in the confinement as well as in the transport direction. They are therefore able to analyze tunneling effects between the source and the drain. For instance, Figure 24 shows how the energy spectrum of the electrons injected from the source in the first unprimed subbands ( $m_l$  in the confinement direction) evolves along the channel for a  $5 \text{ nm} * 10 \text{ nm}$  device. This spectroscopy has been done for a low

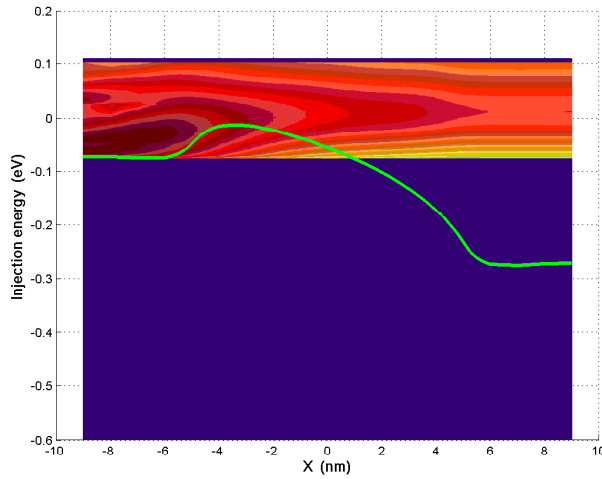


Figure 24: Source-injected electron population (configuration  $m_x = m_l$ ) in log. scale and the tunneling effect beneath the potential barrier (full line) for  $V_{DS} = 0.2V$  and  $V_{GS} = 0.1V$ .

$V_{GS}$  bias voltage and medium drain voltage. It shows that the leakage current which

flows through the device is strongly influenced by electrons which are tunneling through the source/channel barrier. This tunneling current leads to a larger drain induced barrier lowering (DIBL), as extracted from current voltage characteristics, compared to the internal barrier modulation by drain voltage. In particular, the barrier lowering is of the order of  $15\text{ meV}$  when the drain voltage increases from  $0.2\text{ V}$  to  $0.5\text{ V}$ . This leads, at a temperature of  $300\text{ K}$ , to a current increase by a factor of 1.79. The transfer characteristics show however a current variation of a factor of about 2.03. This discrepancy is due to the tunneling of electrons through the source/channel barrier. These tunneling electrons bring a non negligible contribution to drain current compared to electrons injected thermionically above the barrier. The important point in our method is that no assumption is needed about the 2D shape of the barrier to evaluate this tunnelling contribution.

## 4.5 A different device design

We present in this section the numerical results obtained with the SDM/WKB method applied on a trapezoidal device design. The aim is to show the capabilities of the SDM/WKB method and to compare and analyze the performances of the different concept devices.

The geometry of the considered MOSFET transistor is represented in Figure 25. The thickness of the oxide layer is kept constant all along the structure and equal  $1\text{ nm}$ . The channel length remains unchanged, equal  $10\text{ nm}$ , as for the previous device, whereas the channel width varies from  $5\text{ nm}$  at the source side to  $3\text{ nm}$  at the drain side. The other parameters are conserved as for the rectangular MOSFET. The difference in the numerical algorithm consists in the fact, that the width of the device is no more constant and equal  $L_z$ , but depends on the  $x$ -coordinate, hence it is denoted by  $L_z(x)$ . For each point  $x$ , the same number of grid points is taken in the confinement direction in the channel, giving thus rise to a non-uniform grid.

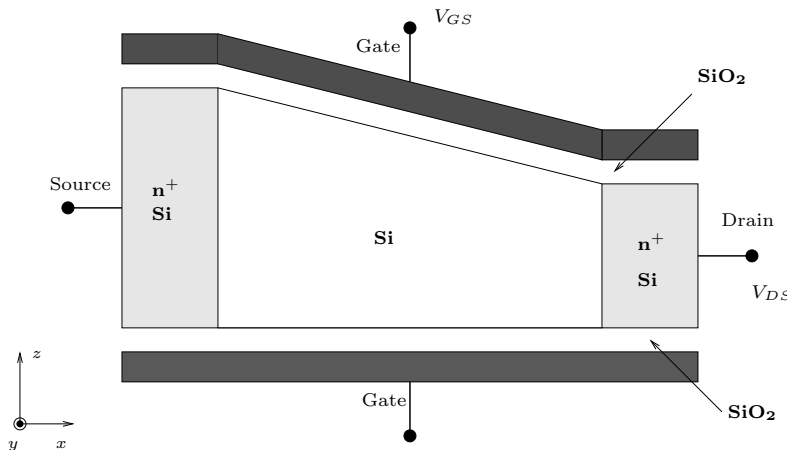


Figure 25: Schematic representation of the trapezoidal MOSFET device.

Figure 26 represents the electron density and the potential energy for the just described device. As expected, the two inversion layers, which are formed at the source side,

merge towards a single channel at the drain side. Moreover Figure 27 (left) illustrates that the energy subbands get more and more distanced as they come closer to the drain. This results in a preference of the electrons for the first subband in the proximity of the drain. In fact, Figure 27 (right) represents the electron occupancy of the first three subbands. It can be observed that the electrons jump towards the first subband as they come nearer to the drain, that means to the narrower region of the transistor.

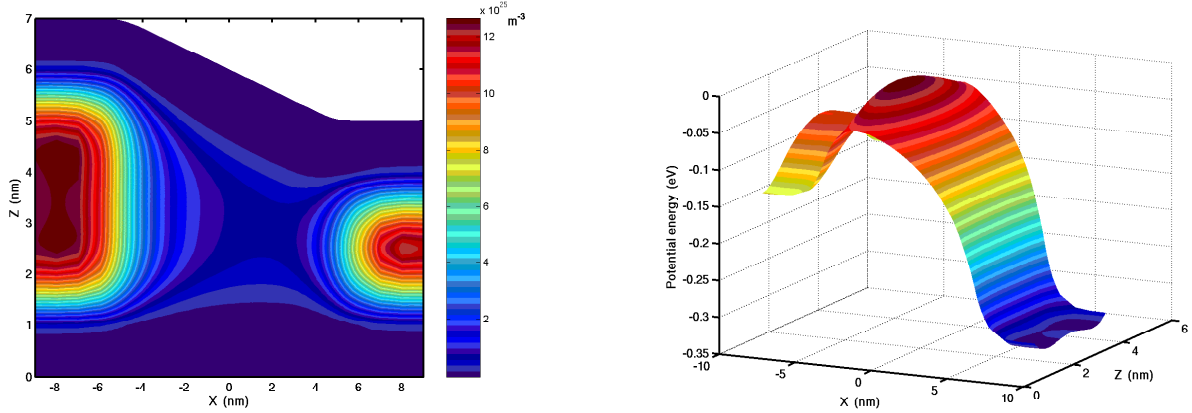


Figure 26: Electron density (left) and potential energy (right) for  $V_{DS} = 0.2V$  and  $V_{GS} = 0.1V$ .

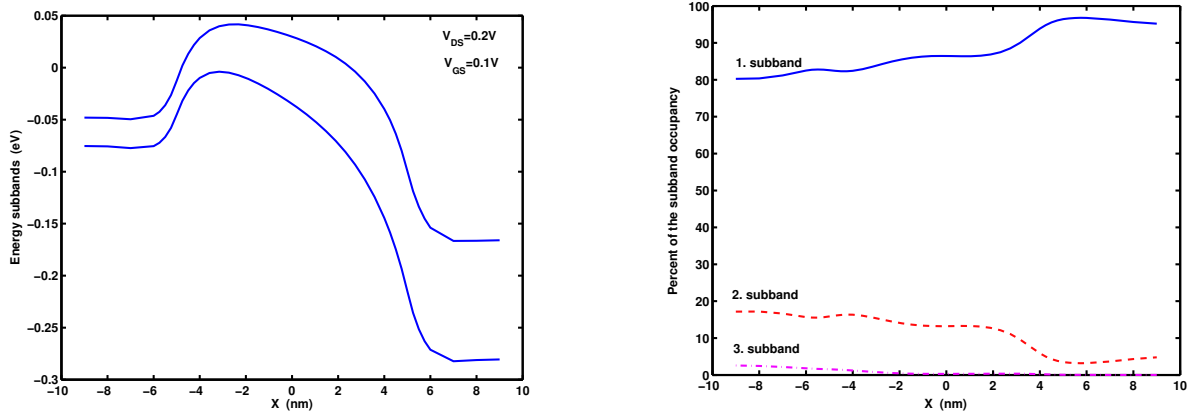


Figure 27: Left: First two conduction energy subbands associated to  $m_l$ , for  $V_{DS} = 0.2V$  and  $V_{GS} = 0.1V$ . Right: Percentage of the subband occupancy for the trapezoidal MOSFET, for  $V_{DS} = 0.2V$  and  $V_{GS} = 0.1V$ .

Finally the comparison of the characteristics of the considered trapezoidal device with that ones corresponding to the rectangular MOSFETs of a  $Si$  thickness of  $5 \text{ nm}$  respectively  $3 \text{ nm}$ , illustrates that the performances of the trapezoidal device are placed between the two respective rectangular MOSFETs (see Figure 28).

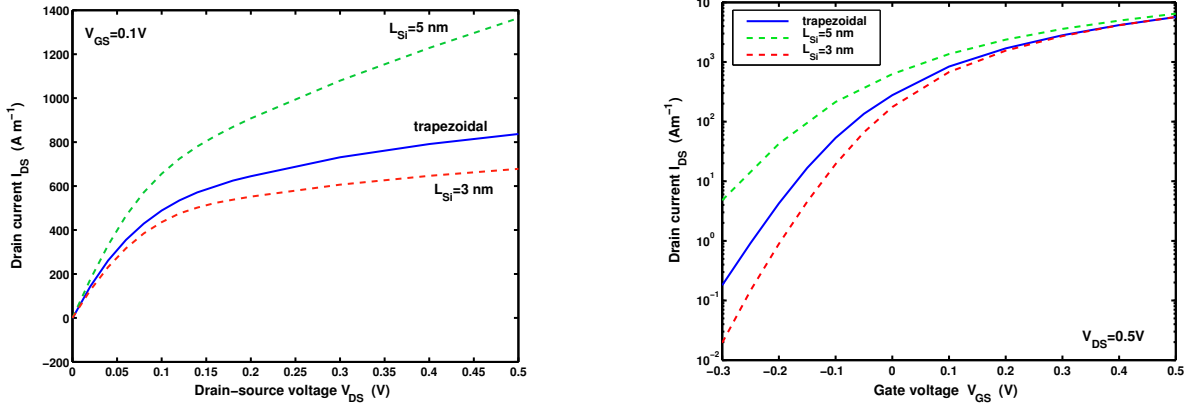


Figure 28: Comparison of the current versus drain-source voltage characteristics for  $V_{GS} = 0.1V$  (left) and current versus gate voltage characteristics for  $V_{DS} = 0.5V$  (right) for different device designs.

## 5 Conclusion

A quantum ballistic transport model, which combines two methods, the SDM method and the WKB approximation, was investigated in this paper. The approach is based on the self-consistent resolution of the Schrödinger-Poisson system with quantum transmitting boundary conditions and was applied for the simulation of nanoscale double-gate MOSFETs. The present study has shown the efficiency of the SDM/WKB method. Accurate results have been obtained with significantly reduced computational time compared to standard methods. In a future work we shall apply the here introduced SDM/WKB method to simulate other type of MOSFET devices, like non-symmetric double-gate MOSFETs, including also surface roughness at the oxide interface.

### Acknowledgments

This work has been supported by the HYKE network (Hyperbolic and Kinetic Equations: Asymptotics, Numerics, Analysis), Ref. HPRN-CT-2002-00282, and by the ACI Nouvelles Interfaces des Mathématiques MOQUA (ACINIM 176-2004), funded by the French Ministry of Research.

## References

- [1] T. Ando, B. Fowler, F. Stern, *Electronic properties of two-dimensional systems*, Rev. Mod. Phys. **54** (1982), 437–672.
- [2] G. Bastard, *Wave mechanics applied to semiconductor heterostructures*, Les éditions de physique (1996).
- [3] N. Ben Abdallah, *On a multidimensional Schrödinger-Poisson scattering model for semiconductors*, J. Math. Phys. **41** (2000), no. 3-4, 4241–4261.
- [4] N. Ben Abdallah, P. Degond, P.A. Markowich, *On a One-Dimensional Schrödinger-Poisson Scattering Model*, ZAMP **48** (1997), 35-55.

- [5] N. Ben Abdallah, O. Pinaud *Improved simulation of open quantum systems: resonances and WKB interpolation schemes*, submitted in J. Comp. Phys.
- [6] N. Ben Abdallah, E. Polizzi, *Subband decomposition approach for the simulation of quantum electron transport in nanostructures*, J. Comput. Phys. **202** (2005), no. 1, 150–180.
- [7] S. Datta, Electronic Transport in Mesoscopic Systems, Cambridge Univ. Press, Cambridge, UK, 1997.
- [8] S. Datta, *Nanoscale device modelling: the Green's function method*, Superlattices and Microstructures **28** (2000), 253–278.
- [9] J. H. Davies, The physics of low dimensional semiconductors, Cambridge Univ. press (1998).
- [10] M. V. Fischetti, *Theory of electron transport in small semiconductor devices using the Pauli master equation*, J. Appl. Phys. **83** (1998), 270–291.
- [11] M.V. Fischetti, Phys.Rev. B **59** (1999), 4901.
- [12] W. R. Frensley, *Boundary Conditions for open Quantum Systems driven far from Equilibrium*, Reviews of Modern Physics, **62** (1990), no. 3, 745–791.
- [13] C. Greengard, P.-A. Raviart, *A boundary-value problem for the stationary Vlasov-Poisson equation: The plane diode*, Comm. Pure Appl. Math., **43** (1990), 473–507.
- [14] G. Klimeck, R. Lake, R. C. Bowen, W. R. Frensley, T. Moise, *Quantitative resonant tunneling diode simulation*, J. of Appl. Phys. **81** (1997), 3207.
- [15] G. Klimeck, F. Oyafuso, T.B. Boykin, R.C. Bowen, P. von Allmen, Computer Modeling Eng. Sci. (CMES) **3** (2002), 601.
- [16] N. C. Kluksdahl, A. M. Kriman, D.K. Ferry and C. Ringhofer, *Self-consistent Study of the Resonant Tunneling Diode*, Phys. Rev. B, **39** (1989), no. 11, 7720–7735.
- [17] R. Lake, G. Klimeck, R. C. Bowen, D. Jovanovic, *Single and Multi-Band Modeling of Quantum Electron Transport through Layered Semiconductor Devices*, J. of Appl. Phys. **81** (1997), 7845.
- [18] S. E. Laux, A. Kumar, M. V. Fischetti, *Analysis of quantum ballistic electron transport in ultrasmall silicon devices including space-charge and geometric effects*, J. Appl. Phys. **95** (2004), no. 10, 5545–5582.
- [19] C.S. Lent, D.J. Kirkner, *The Quantum Transmitting Boundary Method*, J.Appl.Phys. **67** (1990), 6353-6359.
- [20] C. Negulescu, *Numerical analysis of a multiscale finite element scheme for the resolution of the stationary Schrödinger equation*, submitted to Numerische Mathematik.
- [21] F. Nier, *A stationary Schrödinger-Poisson system arising from the modelling of electronic devices*, Forum Math. **2** (1990), no.5, 489–510.
- [22] E. Polizzi, *Modélisation et simulations numériques du transport quantique balistique dans les nanostructures semi-conductrices*, PhD thesis, INSA Toulouse, 2001.
- [23] R. Saito, G. Dresselhaus, M.S. Dresselhaus, Physical properties of carbon nanotubes, Imperial College Press (1998).
- [24] A. Svizhenko, M.P. Antram, T.R. Govindan, B. Biegel, Device Research Conference 2001 (IEEE, Piscataway, NY 2001), 167-168.

- [25] A. Svizhenko, M. Antram, T. R. Govinda, B. Biegel, R. Venugopal, *J. Appl. Phys.* **91** (2002), 2343.
- [26] R. Venugopal, Z. Ren, S. Datta, M. S. Lundstrom, D. Jovanovic, *Simulating Quantum Transport in Nanoscale MOSFETs: Real vs. Mode Space Approaches*, *J. Appl. Physics*, October, 2002, Vol. 92, p. 3730-3739.